

*ASSP Communication Control***IEEE 1394 Open HCI Controller****MB86613****■ DESCRIPTION**

The MB86613 is a high-performance, host-bus (PCI) and serial-bus (1394) controller chip for controlling transfer between the PCI and 1394 buses. This chip conforms to the PCI Standard Version 2.1 for PCI control, the IEEE 1394-1995 Standard for 1394 control, and the Open HCI Standard Version 1.0 for PCI-1394 control.

The MB86613 consists of the PCI/DMA, OHCI, and 1394 blocks. The PCI/DMA block provides PCI bus protocol control. The block has the slave function for responding register access from a bus master, the master function for issuing transfer requests from the MB86613 as the bus master, the power management function (compliant with PCI bus power management standard version 1.0), and the interfaces to BIOS ROM and PCI configuration ROM.

The OHCI block analyzes context programs pre-stored in host memory to store the packet to be sent out from host memory to the FIFO buffer or to store the received packet from the FIFO buffer to host memory.

The 1394 block incorporates the LINK layer module, PHYSical layer module, 1394 transceiver, comparator, and PLL, providing 1394 bus protocol control. The block converts the packet stored in the FIFO buffer to serial data and send it onto the 1394 bus or converts the packet received from the 1394 bus to parallel data and stores it in the FIFO buffer.

For packet transmission and reception, the chip supports a transfer rate of up to S400.

In addition, the cycle master function is provided for automatic management of isochronous cycles.

The chip reserves 6K bytes of FIFO memory. The on-chip dual port RAM contains 3K bytes for packet transmission and 3K bytes for packet reception.

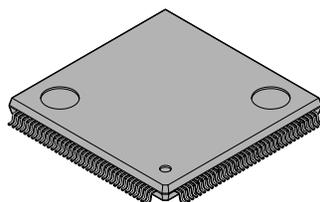
The MB86613 uses the 0.35 micron CMOS process technology, integrating the LINK and PHYSical layer modules on this single chip to reduce the packaging area and power consumption.

The chip has a dual-voltage system to support both 5 V (PCI/DMA) and 3.3 V (1394) power-supply voltages. Note that the PCI/DMA block can operate at 3.3 V.

The package is a plastic package of LQFP144 or FBGA176.

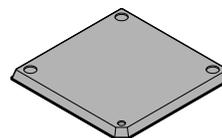
■ PACKAGES

144-pin plastic LQFP



(FPT-144P-M08)

176-pin plastic FBGA



(BGA-176P-M02)

MB86613

■ FEATURES

1. 1394 serial bus controller Unit

- Compliant with IEEE 1394-1995 Standard
- PHYSical and LINK layer modules integrated on a single chip
- Three internal ports
- Transfer rates of S100, S200, and S400 supported
- On-chip PLL for generating 400-MHz (PHY) and 50-MHz (LINK) CLK signals
- Built-in cycle master function
- Bus management CSR (control and status register)
- Six-conductor cable supported
- Internal transceiver and comparator
- Internal comparator for cable power detection

2. Context program controller unit

- Compliant with Open HCI Standard (Draft 1.00)
- Thirteen context program controllers integrated:

| | | | |
|---------------------------|--------|------------------------|--------|
| Asynchronous Transmit DMA | ...2ch | •Asynchronous response | ...1ch |
| | | •Asynchronous request | ...1ch |
| Isochronous Transmit DMA | ...4ch | | |
| Receive DMA | ...7ch | •Asynchronous response | ...1ch |
| | | •Asynchronous request | ...1ch |
| | | •Isochronous | ...4ch |
| | | •SelfID | ...1ch |
- Internal 6-KB FIFO buffers

| | |
|---------------------------------------|--------------|
| Asynchronous Transmit FIFO | ...1.5 Kbyte |
| isochronous Transmit FIFO | ...1.5 Kbyte |
| Asynchronous/Isochronous Receive FIFO | ...3.0 Kbyte |

3. PCI bus controller unit

- Compliant with PCI Standard (Revision 2.2)
- On-chip 32-bit DMA controller
- Built-in power management function (Compliant with PCI bus power management standard version 1.0)
- Built-in alignment function
- Built-in byte swap function
- Operating frequency of up to 33 MHz
- Internal parallel ROM interface
- Internal serial ROM interface
- Internal universal (5/3.3 V shared) PCI buffer

4. Physical specifications

- Package: LQFP144 (FPT-144P-M08), FBGA176 (BGA-176P-M02)
- Power-supply voltage: Dual system for 5 V ($\pm 5\%$) and 3.3 V ($\pm 5\%$)

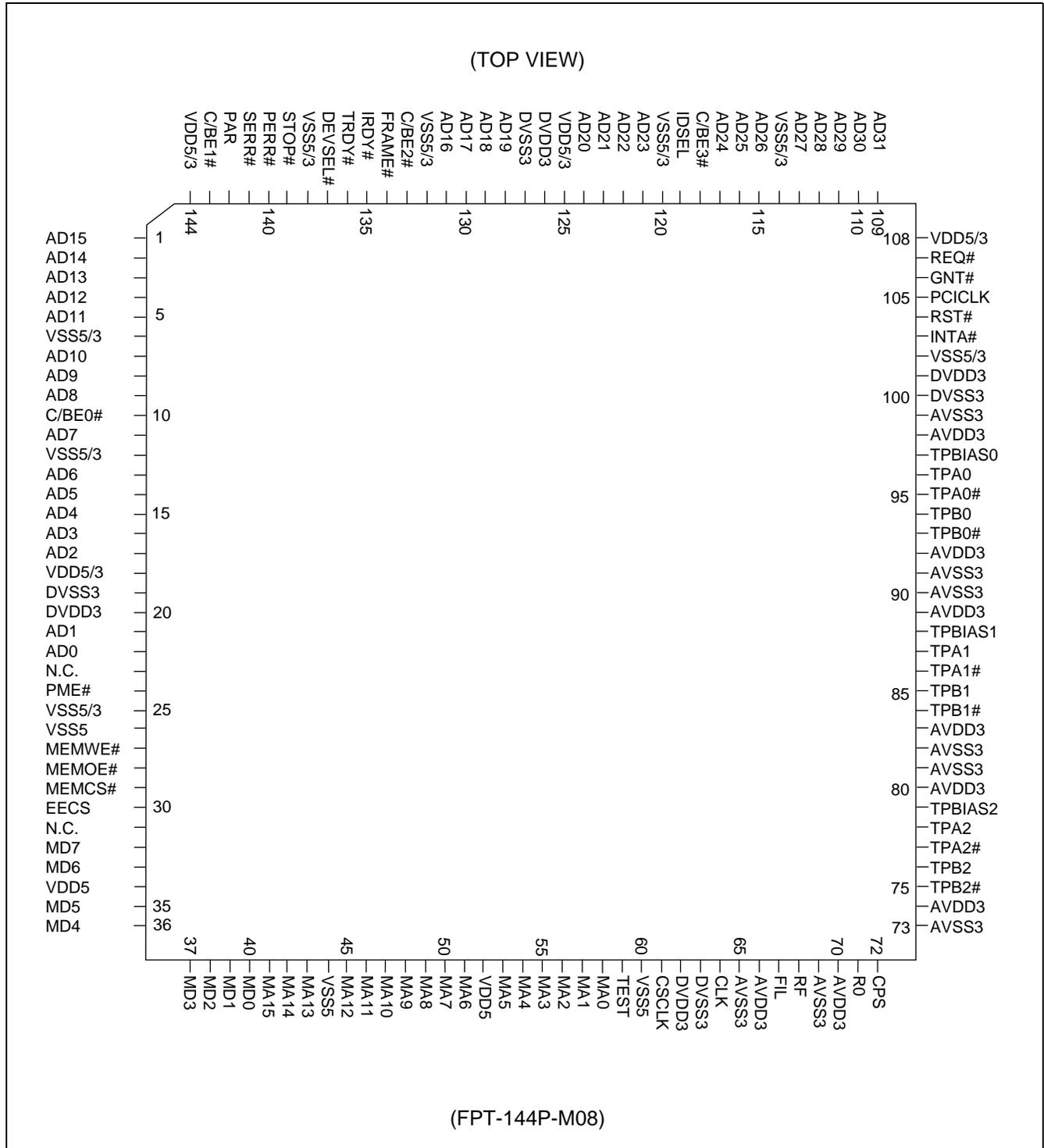
5. Reference standards

- IEEE Standard for a High Performance 1394-1995
- 1394 Open Host Controller Interface Specification (Release 1.00)
- PCI Specification (Revision 2.2)
- PCI Bus Power Management Interface Specification (Version 1.0)

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■ PIN ASSIGNMENT

1. LQFP-144



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2. FBGA-176

| | | | | | | | | | | | | | | |
|---------|--------|---------|--------|-------|------------|--------|-------|--------|---------|--------|--------|--------|--------|---|
| | N.C. | N.C. | AVSS3 | AVSS3 | CCLK | MA1 | MA5 | MA8 | VSS5 | MA15 | MD3 | N.C. | | P |
| N.C. | AVSS3 | N.C. | AVDD3 | AVDD3 | DVDD3 | MA0 | VDD5 | MA9 | VSS3 | MD0 | N.C. | N.C. | N.C. | N |
| TPB2 | TPB2# | N.C. | RO | FIL | DVSS3 | TEST | MA6 | MA10 | MA13 | MD2 | N.C. | N.C. | N.C. | M |
| TPA2 | TPA2# | N.C. | AVDD3 | RF | CLK | MA2 | MA7 | MA11 | MD1 | N.C. | MD5 | VDD5 | MD6 | L |
| AVSS3 | AVDD3 | TPBIAS2 | N.C. | CPS | VSS5 | MA3 | MA4 | MA14 | MD4 | MD7 | N.C. | EECS | MEMCS# | K |
| TPB1 | TPB1# | AVDD3 | AVSS3 | N.C. | (TOP VIEW) | | | | PME# | MEMOE# | MEMWE# | VSS5 | VSS5/3 | J |
| TPBIAS1 | TPA1 | TPA1# | N.C. | AVDD3 | | | | | DVSS3 | DVDD3 | N.C. | AD0 | AD1 | H |
| AVDD3 | TPB0# | TPB0 | AVSS3 | AVSS3 | | | | | VDD5/3 | AD5 | AD4 | AD3 | AD2 | G |
| TPA0# | TPA0 | TPBIAS0 | AVDD3 | N.C. | | | | | VSS5/3 | C/BE0# | AD7 | VSS5/3 | AD6 | F |
| AVSS3 | DVSS3 | DVDD3 | VSS5/3 | GNT# | VSS5/3 | DVDD3 | DVSS3 | VSS5/3 | VDD5/3 | AD13 | AD10 | AD9 | AD8 | E |
| INTA# | RST# | PCICLK | N.C. | AD29 | C/BE3# | AD22 | AD19 | TRDY# | PERR# | N.C. | AD14 | AD12 | AD11 | D |
| REQ# | VDD5/3 | N.C. | AD30 | AD26 | IDSEL | AD22 | AD16 | IRDY# | STOP# | C/BE1# | N.C. | N.C. | AD15 | C |
| N.C. | N.C. | N.C. | AD28 | AD25 | VSS5/3 | AD20 | AD17 | FRAME# | VSS5/3 | PAR | N.C. | N.C. | N.C. | B |
| | N.C. | AD31 | AD27 | AD24 | AD23 | VDD5/3 | AD18 | C/BE2# | DEVSEL# | SERR# | N.C. | N.C. | | A |
| 14 | 13 | 12 | 11 | 10 | 9 | 8 | 7 | 6 | 5 | 4 | 3 | 2 | 1 | |

(BGA-176P-M02)

MB86613**■ PIN LIST****1. LQFP-144**

| Pin No. | I/O | Pin name | Supply Voltage (V) | Pin No. | I/O | Pin name | Supply Voltage (V) |
|---------|-----|----------|--------------------|---------|-----|----------|--------------------|
| 1 | I/O | AD15 | 5/3.3 | 36 | I/O | MD4 | 5 |
| 2 | I/O | AD14 | 5/3.3 | 37 | I/O | MD3 | 5 |
| 3 | I/O | AD13 | 5/3.3 | 38 | I/O | MD2 | 5 |
| 4 | I/O | AD12 | 5/3.3 | 39 | I/O | MD1 | 5 |
| 5 | I/O | AD11 | 5/3.3 | 40 | I/O | MD0 | 5 |
| 6 | — | VSS5/3 | — | 41 | O | MA15 | 5 |
| 7 | I/O | AD10 | 5/3.3 | 42 | O | MA14 | 5 |
| 8 | I/O | AD9 | 5/3.3 | 43 | O | MA13 | 5 |
| 9 | I/O | AD8 | 5/3.3 | 44 | — | VSS5 | — |
| 10 | I/O | C/BE0# | 5/3.3 | 45 | O | MA12 | 5 |
| 11 | I/O | AD7 | 5/3.3 | 46 | O | MA11 | 5 |
| 12 | — | VSS5/3 | — | 47 | O | MA10 | 5 |
| 13 | I/O | AD6 | 5/3.3 | 48 | O | MA9 | 5 |
| 14 | I/O | AD5 | 5/3.3 | 49 | O | MA8 | 5 |
| 15 | I/O | AD4 | 5/3.3 | 50 | O | MA7 | 5 |
| 16 | I/O | AD3 | 5/3.3 | 51 | O | MA6 | 5 |
| 17 | I/O | AD2 | 5/3.3 | 52 | — | VDD5 | — |
| 18 | — | VDD5/3 | — | 53 | O | MA5 | 5 |
| 19 | — | DVSS3 | — | 54 | O | MA4 | 5 |
| 20 | — | DVDD3 | — | 55 | O | MA3 | 5 |
| 21 | I/O | AD1 | 5/3.3 | 56 | O | MA2 | 5 |
| 22 | I/O | AD0 | 5/3.3 | 57 | O | MA1 | 5 |
| 23 | — | N.C | — | 58 | O | MA0 | 5 |
| 24 | O | PME# | 5/3.3 | 59 | I | TEST | 5 |
| 25 | — | VSS5/3 | — | 60 | — | VSS5 | — |
| 26 | — | VSS5 | — | 61 | I | CSCLK | 5/3.3 |
| 27 | O | MEMWE# | 5 | 62 | — | DVDD3 | — |
| 28 | O | MEMOE# | 5 | 63 | — | DVSS3 | — |
| 29 | O | MEMCS# | 5 | 64 | I | CLK | 5/3.3 |
| 30 | O | EECS | 5 | 65 | — | AVSS3 | — |
| 31 | — | N.C | — | 66 | — | AVDD3 | — |
| 32 | I/O | MD7 | 5 | 67 | I | FIL | 3.3 |
| 33 | I/O | MD6 | 5 | 68 | O | RF | 3.3 |
| 34 | — | VDD5 | — | 69 | — | AVSS3 | — |
| 35 | I/O | MD5 | 5 | 70 | — | AVDD3 | — |

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| Pin No. | I/O | Pin name | Supply Voltage (V) | Pin No. | I/O | Pin name | Supply Voltage (V) |
|---------|-----|----------|--------------------|---------|-----|----------|--------------------|
| 71 | O | R0 | 3.3 | 108 | — | VDD5/3 | — |
| 72 | I | CPS | 3.3 | 109 | I/O | AD31 | 5/3.3 |
| 73 | — | AVSS3 | — | 110 | I/O | AD30 | 5/3.3 |
| 74 | — | AVDD3 | — | 111 | I/O | AD29 | 5/3.3 |
| 75 | I/O | TPB2# | 3.3 | 112 | I/O | AD28 | 5/3.3 |
| 76 | I/O | TPB2 | 3.3 | 113 | I/O | AD27 | 5/3.3 |
| 77 | I/O | TPA2# | 3.3 | 114 | — | VSS5/3 | — |
| 78 | I/O | TPA2 | 3.3 | 115 | I/O | AD26 | 5/3.3 |
| 79 | O | TPBIAS2 | 3.3 | 116 | I/O | AD25 | 5/3.3 |
| 80 | — | AVDD3 | — | 117 | I/O | AD24 | 5/3.3 |
| 81 | — | AVSS3 | — | 118 | I/O | C/BE3# | 5/3.3 |
| 82 | — | AVSS3 | — | 119 | I | IDSEL | 5/3.3 |
| 83 | — | AVDD3 | — | 120 | — | VSS5/3 | — |
| 84 | I/O | TPB1# | 3.3 | 121 | I/O | AD23 | 5/3.3 |
| 85 | I/O | TPB1 | 3.3 | 122 | I/O | AD22 | 5/3.3 |
| 86 | I/O | TPA1# | 3.3 | 123 | I/O | AD21 | 5/3.3 |
| 87 | I/O | TPA1 | 3.3 | 124 | I/O | AD20 | 5/3.3 |
| 88 | O | TPBIAS1 | 3.3 | 125 | — | VDD5/3 | — |
| 89 | — | AVDD3 | — | 126 | — | DVDD3 | — |
| 90 | — | AVSS3 | — | 127 | — | DVSS3 | — |
| 91 | — | AVSS3 | — | 128 | I/O | AD19 | 5/3.3 |
| 92 | — | AVDD3 | — | 129 | I/O | AD18 | 5/3.3 |
| 93 | I/O | TPB0# | 3.3 | 130 | I/O | AD17 | 5/3.3 |
| 94 | I/O | TPB0 | 3.3 | 131 | I/O | AD16 | 5/3.3 |
| 95 | I/O | TPA0# | 3.3 | 132 | — | VSS5/3 | — |
| 96 | I/O | TPA0 | 3.3 | 133 | I/O | C/BE2# | 5/3.3 |
| 97 | O | TPBIAS0 | 3.3 | 134 | I/O | FRAME# | 5/3.3 |
| 98 | — | AVDD3 | — | 135 | I/O | IRDY# | 5/3.3 |
| 99 | — | AVSS3 | — | 136 | I/O | TRDY# | 5/3.3 |
| 100 | — | DVSS3 | — | 137 | I/O | DEVSEL# | 5/3.3 |
| 101 | — | DVDD3 | — | 138 | — | VSS5/3 | — |
| 102 | — | VSS5/3 | — | 139 | I/O | STOP# | 5/3.3 |
| 103 | OD | INTA# | 5/3.3 | 140 | I/O | PERR# | 5/3.3 |
| 104 | I | RST# | 5/3.3 | 141 | OD | SERR# | 5/3.3 |
| 105 | I | PCICLK | 5/3.3 | 142 | I/O | PAR | 5/3.3 |
| 106 | I | GNT# | 5/3.3 | 143 | I/O | C/BE1# | 5/3.3 |
| 107 | O | REQ# | 5/3.3 | 144 | — | VDD5/3 | — |

MB86613**2. FBGA-176**

| Ball No. | I/O | Pin name | Supply Voltage (V) | Ball No. | I/O | Pin name | Supply Voltage (V) |
|----------|-----|----------|--------------------|----------|-----|----------|--------------------|
| B1 | — | N.C. | — | K4 | I/O | MD7 | 5 |
| B2 | — | N.C. | — | L1 | I/O | MD6 | 5 |
| D4 | — | N.C. | — | L2 | — | VDD5 | — |
| C2 | — | N.C. | — | L3 | I/O | MD5 | 5 |
| C1 | I/O | AD15 | 5/3.3 | K5 | I/O | MD4 | 5 |
| D3 | I/O | AD14 | 5/3.3 | M1 | — | N.C. | — |
| E4 | I/O | AD13 | 5/3.3 | M2 | — | N.C. | — |
| D2 | I/O | AD12 | 5/3.3 | M3 | — | N.C. | — |
| D1 | I/O | AD11 | 5/3.3 | N1 | — | N.C. | — |
| F5 | — | VSS5/3 | — | P2 | — | N.C. | — |
| E3 | I/O | AD10 | 5/3.3 | N2 | — | N.C. | — |
| E2 | I/O | AD9 | 5/3.3 | L4 | — | N.C. | — |
| E1 | I/O | AD8 | 5/3.3 | N3 | — | N.C. | — |
| F4 | I/O | C/BE0# | 5/3.3 | P3 | I/O | MD3 | 5 |
| F3 | I/O | AD7 | 5/3.3 | M4 | I/O | MD2 | 5 |
| F2 | — | VSS5/3 | — | L5 | I/O | MD1 | 5 |
| F1 | I/O | AD6 | 5/3.3 | N4 | I/O | MD0 | 5 |
| G4 | I/O | AD5 | 5/3.3 | P4 | O | MA15 | 5 |
| G3 | I/O | AD4 | 5/3.3 | K6 | O | MA14 | 5 |
| G2 | I/O | AD3 | 5/3.3 | M5 | O | MA13 | 5 |
| G1 | I/O | AD2 | 5/3.3 | N5 | — | VSS5 | — |
| G5 | — | VDD5/3 | — | P5 | O | MA12 | 5 |
| H5 | — | DVSS3 | — | L6 | O | MA11 | 5 |
| H4 | — | DVDD3 | — | M6 | O | MA10 | 5 |
| H1 | I/O | AD1 | 5/3.3 | N6 | O | MA9 | 5 |
| H2 | I/O | AD0 | 5/3.3 | P6 | O | MA8 | 5 |
| H3 | — | N.C. | — | L7 | O | MA7 | 5 |
| J5 | OD | PME# | 5/3.3 | M7 | O | MA6 | 5 |
| J1 | — | VSS5/3 | — | N7 | — | VDD5 | — |
| J2 | — | VSS5 | — | P7 | O | MA5 | 5 |
| J3 | O | MEMWE# | 5 | K7 | O | MA4 | 5 |
| J4 | O | MEMOE# | 5 | K8 | O | MA3 | 5 |
| K1 | O | MEMCS# | 5 | L8 | O | MA2 | 5 |
| K2 | O | EECS | 5 | P8 | O | MA1 | 5 |
| K3 | — | N.C. | — | N8 | O | MA0 | 5 |

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| Ball No. | I/O | Pin name | Supply Voltage (V) | Ball No. | I/O | Pin name | Supply Voltage (V) |
|----------|-----|----------|--------------------|----------|-----|----------|--------------------|
| M8 | I | TEST | 5 | H11 | — | N.C. | — |
| K9 | — | VSS5 | — | H12 | I/O | TPA#1 | 3.3 |
| P9 | I | CSCLK | 5/3.3 | H13 | I/O | TPA1 | 3.3 |
| N9 | — | DVDD3 | — | H14 | O | TPBIAS1 | 3.3 |
| M9 | — | DVSS3 | — | H10 | — | AVDD3 | — |
| L9 | I | CLK | 5/3.3 | G10 | — | AVSS3 | — |
| P10 | — | AVSS3 | — | G11 | — | AVSS3 | — |
| N10 | — | AVDD3 | — | G14 | — | AVDD3 | — |
| M10 | I | FIL | 3.3 | G13 | I/O | TPB0# | 3.3 |
| L10 | O | RF | 3.3 | G12 | I/O | TPB0 | 3.3 |
| P11 | — | AVSS3 | — | F10 | — | N.C. | — |
| N11 | — | AVDD3 | — | F14 | I/O | TPA0# | 3.3 |
| M11 | O | R0 | 3.3 | F13 | I/O | TPA0 | 3.3 |
| K10 | I | CPS | 3.3 | F12 | O | TPBIAS0 | 3.3 |
| P12 | — | N.C. | — | F11 | — | AVDD3 | — |
| N12 | — | N.C. | — | E14 | — | AVSS3 | — |
| M12 | — | N.C. | — | E13 | — | DVSS3 | — |
| P13 | — | N.C. | — | E12 | — | DVDD3 | — |
| N14 | — | N.C. | — | E11 | — | VSS5/3 | — |
| N13 | — | AVSS3 | — | D14 | OD | INTA# | 5/3.3 |
| L11 | — | AVDD3 | — | D13 | I | RST# | 5/3.3 |
| M13 | I/O | TPB2# | 3.3 | D12 | I | PCICLK | 5/3.3 |
| M14 | I/O | TPB2 | 3.3 | E10 | I | GNT# | 5/3.3 |
| L12 | — | N.C. | — | C14 | O | REQ# | 5/3.3 |
| K11 | — | N.C. | — | C13 | — | VDD5/3 | — |
| L13 | I/O | TPA2# | 3.3 | C12 | — | N.C. | — |
| L14 | I/O | TPA2 | 3.3 | B14 | — | N.C. | — |
| J10 | — | N.C. | — | A13 | — | N.C. | — |
| K12 | O | TPBIAS2 | 3.3 | B13 | — | N.C. | — |
| K13 | — | AVDD3 | — | D11 | — | N.C. | — |
| K14 | — | AVSS3 | — | B12 | — | N.C. | — |
| J11 | — | AVSS3 | — | A12 | I/O | AD31 | 5/3.3 |
| J12 | — | AVDD3 | — | C11 | I/O | AD30 | 5/3.3 |
| J13 | I/O | TPB1# | 3.3 | D10 | I/O | AD29 | 5/3.3 |
| J14 | I/O | TPB1 | 3.3 | B11 | I/O | AD28 | 5/3.3 |

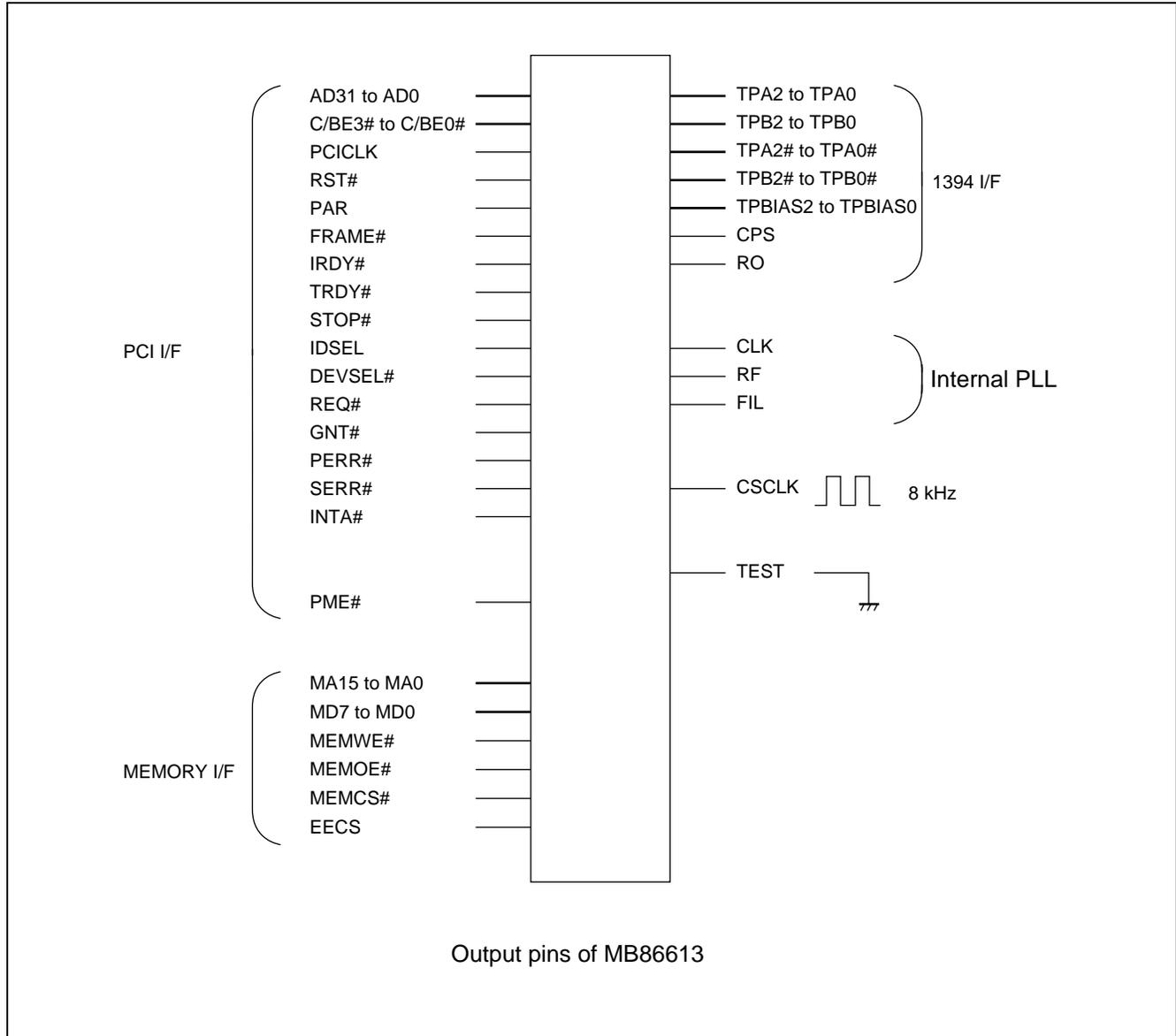
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| Ball No. | I/O | Pin name | Supply Voltage (V) | Ball No. | I/O | Pin name | Supply Voltage (V) |
|-----------------|------------|-----------------|---------------------------|-----------------|------------|-----------------|---------------------------|
| A11 | I/O | AD27 | 5/3.3 | C7 | I/O | AD16 | 5/3.3 |
| E9 | — | VSS5/3 | — | E6 | — | VSS5/3 | — |
| C10 | I/O | AD26 | 5/3.3 | A6 | I/O | C/BE2# | 5/3.3 |
| B10 | I/O | AD25 | 5/3.3 | B6 | I/O | FRAME# | 5/3.3 |
| A10 | I/O | AD24 | 5/3.3 | C6 | I/O | IRDY# | 5/3.3 |
| D9 | I/O | C/BE3# | 5/3.3 | D6 | I/O | TRDY# | 5/3.3 |
| C9 | I | IDSEL | 5/3.3 | A5 | I/O | DEVSEL# | 5/3.3 |
| B9 | — | VSS5/3 | — | B5 | — | VSS5/3 | — |
| A9 | I/O | AD23 | 5/3.3 | C5 | I/O | STOP# | 5/3.3 |
| D8 | I/O | AD22 | 5/3.3 | D5 | I/O | PERR# | 5/3.3 |
| C8 | I/O | AD21 | 5/3.3 | A4 | OD | SERR# | 5/3.3 |
| B8 | I/O | AD20 | 5/3.3 | B4 | I/O | PAR | 5/3.3 |
| A8 | — | VDD5/3 | — | C4 | I/O | C/BE1# | 5/3.3 |
| E8 | — | DVDD3 | — | E5 | — | VDD5/3 | — |
| E7 | — | DVSS3 | — | A3 | — | N.C. | — |
| D7 | I/O | AD19 | 5/3.3 | B3 | — | N.C. | — |
| A7 | I/O | AD18 | 5/3.3 | C3 | — | N.C. | — |
| B7 | I/O | AD17 | 5/3.3 | A2 | — | N.C. | — |

MB86613

■ PIN DESCRIPTION



1. PCI Interface Pin Description

| Pin name | I/O | Function |
|------------------|-----|---|
| AD31 to AD0 | I/O | 32-bit data/address multiplexed signal |
| C/BE3# to C/BE0# | I/O | Bus-command and byte-enable multiplexed signal |
| PCICLK | I | PCI bus clock input pin (Up to 33 MHz) |
| RST# | I | System reset input pin |
| PAR | I/O | Even parity bit for AD31:0 and C/BE3:0. Enabled one PCI clock signal after address phase. |
| FRAME# | I/O | Signal indicating that the bus is being driven by the master. |
| IRDY# | I/O | Master data ready signal |
| TRDY# | I/O | Target data ready signal |
| STOP# | I/O | Target-to-master data transfer stop request signal |
| IDSEL | I | Chip select signal for accessing the configuration register |
| DEVSEL# | I/O | During target operation: Output signal indicating that the this device has been selected. During master operation: Input signal indicating that the device connected to the PCI bus has been selected. |
| REQ# | O | Output signal requesting the bus arbiter for using the PCI bus |
| GNT# | I | Input signal for bus arbiter's response to REQ# |
| PERR# | I/O | Data parity error I/O signal |
| SERR# | OD | Address parity error I/O signal |
| INTA# | OD | Interrupt output signal |
| PME# | OD | Power supply request signal in power save mode |

2. Memory Interface Pin Description

| Pin name | I/O | Function |
|-------------|-----|---|
| MA15 to MA0 | O | Externally-connected EPROM (BIOS ROM) address signal |
| MD7 to MD0 | I/O | Externally-connected EPROM (BIOS ROM) data signal |
| MEMWE# | O | Connect this pin to the WE pin on the externally-connected EPROM (BIOS ROM) |
| MEMOE# | O | Connect this pin to the OE pin on the externally-connected EPROM (BIOS ROM) |
| MEMCS# | O | Connect this pin to the CS pin on the externally-connected EPROM (BIOS ROM) |
| EECS | O | Connect this pin to the CS pin on the externally-connected EEPROM (PCI configuration ROM) |

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3. 1394 Interface Pin Description

| Pin name | I/O | Function |
|--------------------|-----|--|
| TPA2 to TPA0 | I/O | Differential I/O positive terminal of 1394 bus port A |
| TPB2 to TPB0 | I/O | Differential I/O positive terminal of 1394 bus port B |
| TPA2# to TPA0# | I/O | Differential I/O negative terminal of 1394 bus port A |
| TPB2# to TPB0# | I/O | Differential I/O negative terminal of 1394 bus port B |
| TPBIAS2 to TPBIAS0 | O | 1394 bus bias voltage supply pin. For connecting a terminal resistor to TPBIAS and TPA/B, see “ ■COMPONENT CONNECTION DIAGRAM 1. 1394 Ports ”. |
| CPS | I | Cable power input pin |
| RO | O | Connect a 5.1 k Ω resistor between the RO and GND pins. For details, see “ ■COMPONENT CONNECTION DIAGRAM 1. 1394 Ports ”. |

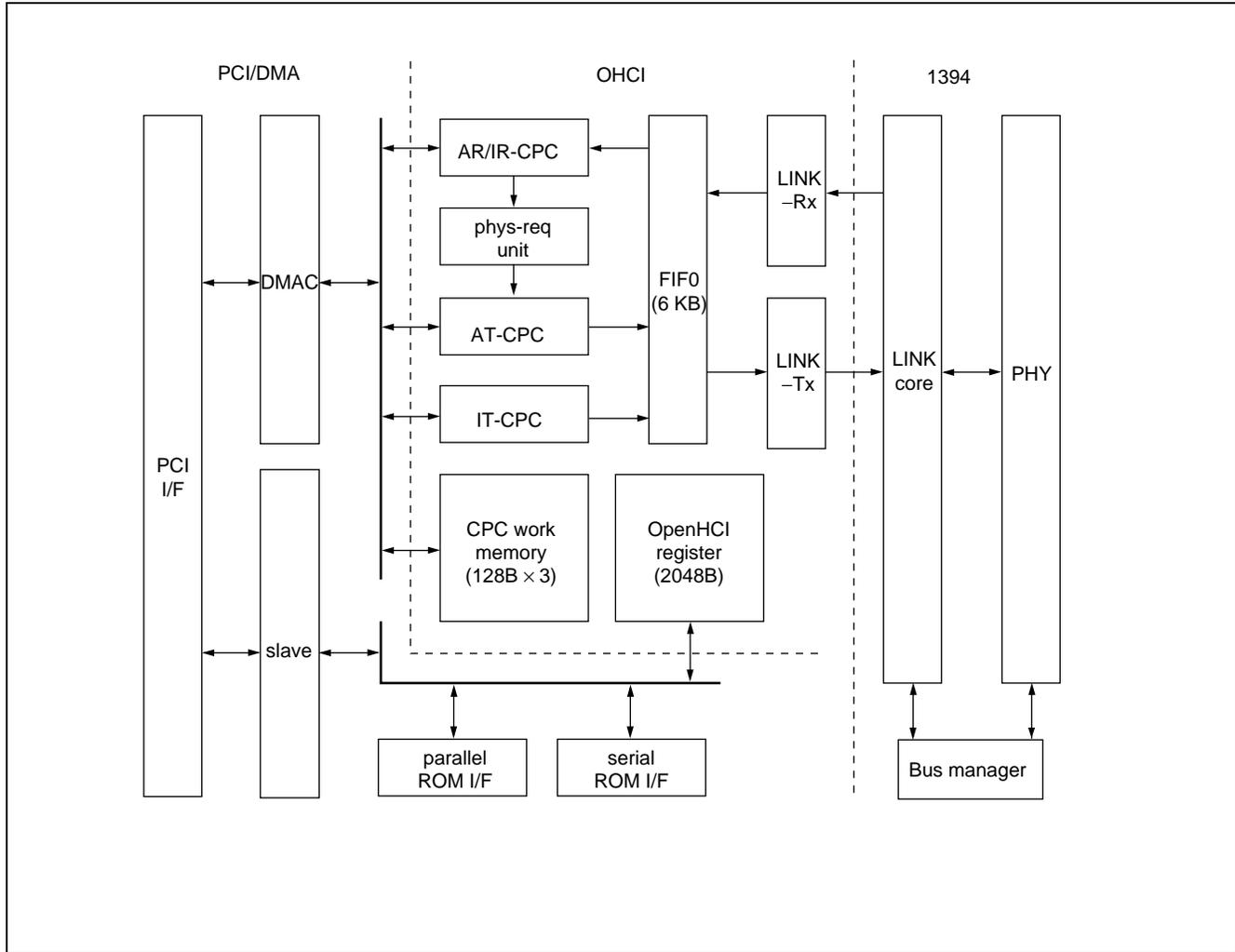
4. Internal PLL Pin Description

| Pin name | I/O | Function |
|----------|-----|--|
| CLK | I | Internal PLL clock input pin. Input a 24.576 MHz clock signal. |
| RF | O | Connect a 5.6 k Ω resistor between the RO and GND pins. For details, see “ ■COMPONENT CONNECTION DIAGRAM 2. Filter Circuit ”. |
| FIL | O | Filter circuit connection pin. For connecting the filter circuit, see “ ■COMPONENT CONNECTION DIAGRAM 2. Filter Circuit ”. |

5. Miscellaneous Pin Description

| Pin name | I/O | Function |
|----------|-----|--|
| CSCLK | I | This pin inputs the trigger signal for sending a cycle start packet during cycle master operation. Input an 8 kHz (125 μ s) clock signal. If the CLK pin is not used (with no Link Control. cycle Source bit set), however, connect this pin to GND. |
| TEST | I | This pin is used for test mode. During normal operation, leave this pin connected to GND. |
| N.C. | — | Leave this pin unconnected. |

■ BLOCK DIAGRAM



MB86613

■ BLOCK DESCRIPTION

- Parallel ROM I/F

This block is the parallel port ROM interface to which EPROM (BIOS ROM) with a data width of 8 bits and that EEPROM (PCI configuration ROM) are connected which contains PCI subsystem ID and subsystem vendor ID information. For details, see “ ■COMPONENT CONNECTION DIAGRAM 3. Memory Interface”

- CPC (context program controller)

This block analyzes context programs stored in host memory to store the packet to be sent out from host memory to the FIFO buffer or to store the received packet from the FIFO buffer to host memory (AR-CPC, IR-CPC). Upon reception of a physical request packet, this block analyzes the packet automatically for servicing the request (phys-req unit).

- CPC work memory

This block is work memory which stores context programs prepared in host memory or packet header information upon reception of a physical request packet.

- OHCI register

This block holds 2048 bytes of registers defined in the Open HCI Standard.

- FIFO

This block is a 6-KB FIFO buffer. This FIFO consists of a transmit-packet storage area (AT-FIFO and IT-FIFO) and a receive-packet storage area (AR-FIFO and IR-FIFO), each of which is freely addressable.

- LINK-Rx

This block stores the LINK-received, 1394-formatted packet in the FIFO buffer, with trailer data defined in the Open HCI Standard added.

- LINK-Tx

This block converts the packet stored in the FIFO buffer into the 1394 format and sends it to the LINK.

- PCI I/F

This block provides PCI bus protocol control.

- PCI-DMAC

This block issues a transfer request with the MB86613 serving as the bus master.

- PCI-slave

This block responds to the register access from the bus master.

- LINK core

This block generates data CRC and header CRC, transmits the selfID packet, and controls packet transmission and reception.

- PHY

This block provides 1394 bus protocol control.

- Bus manager

This block manages the cycle timer, generates a variety of interrupts, and holds the bus management CSR.

■ ABSOLUTE MAXIMUM RATINGS

| Parameter | | Symbol | Rating | | Unit |
|--------------------------------|----------|-----------------|-----------------------|-----------------------|------|
| | | | Min. | Max. | |
| Power supply voltage*1 | at 5 V*2 | V _{DD} | V _{SS} - 0.5 | 6.0 | V |
| | at 3 V*3 | | V _{SS} - 0.5 | 4.0 | |
| Input current*1 | | V _I | V _{SS} - 0.5 | V _{DD} + 0.5 | V |
| Output current*1 | | V _O | V _{SS} - 0.5 | V _{DD} + 0.5 | V |
| Storage temperature | | T _{ST} | -55 | +125 | °C |
| Operating junction temperature | | T _{OP} | -40 | +125 | °C |

*1 : The voltages are based on V_{SS} = 0 V.

*2 : The 5 V power supply is the voltage applied at the VDD5/3 and VDD5 power supply pins.

*3 : The 3 V power supply is the voltage applied at the DVDD3 and AVDD3 power supply pins.

WARNING: Semiconductor devices can be permanently damaged by application of stress (voltage, current, temperature, etc.) in excess of absolute maximum ratings. Do not exceed these ratings.

MB86613

■ RECOMMENDED OPERATING CONDITIONS

| Parameter | | Symbol | Value | | Unit |
|-------------------------------|-------------------|-----------|-------|---------|-------------------|
| | | | Min. | Max. | |
| Power supply voltage*1 | at 5 V*2 | V_{DD5} | 4.75 | 5.25 | V |
| | at 3 V*3 | V_{DD3} | 3.0 | 3.6 | |
| Differential input voltage | TPA/B arbitration | V_{ID} | 168 | 265 | mV p-p diff |
| | TPA/B S100*4 | | 142 | 260 | |
| | TPA/B S200*4 | | 132 | 260 | |
| | TPA/B S400*4 | | 118 | 260 | |
| TPBias input voltage | TPA/B S100*4 | V_{CM} | 1.165 | 2.515*5 | V |
| | TPA/B S200*4 | | 0.935 | 2.515*5 | |
| | TPA/B S400*4 | | 0.523 | 2.515*5 | |
| Receiving input jitter | TPA/B S100*4 | — | — | ±1.08 | ns |
| | TPA/B S200*4 | | — | ±0.5 | |
| | TPA/B S400*4 | | — | ±0.315 | |
| Receiving input skew*6 | TPA/B S100*4 | — | — | ±0.8 | ns |
| | TPA/B S200*4 | | — | ±0.55 | |
| | TPA/B S400*4 | | — | ±0.5 | |
| Output current | TPBIAS pin | I_o | -2 | +2 | mA |
| | MD pin | | -4 | +4 | |
| Operating ambient temperature | | T_a | 0 | 70 | °C |

*1 : Voltage values are based on $V_{SS} = 0V$.

*2 : The 5 V power supply is the voltage applied at the $V_{DD5/3}$ and V_{DD5} power supply pins.

*3 : The 3 V power supply is the voltage applied at the DV_{DD3} and AV_{DD3} power supply pins.

*4 : During speed signaling

*5 : With cable power feed, the value is 2.015 (V).

*6 : Skew between TPA pin and TPB pin.

WARNING: The recommended operating conditions are required in order to ensure the normal operation of the semiconductor device. All of the device's electrical characteristics are warranted when the device is operated within these ranges.

Always use semiconductor devices within their recommended operating condition ranges. Operation outside these ranges may adversely affect reliability and could result in device failure.

No warranty is made with respect to uses, operating conditions, or combinations not represented on the data sheet. Users considering application outside the listed conditions are advised to contact their FUJITSU representatives beforehand.

■ ELECTRICAL CHARACTERISTICS

1. DC Characteristics

($V_{DD} = 4.75$ to 5.25 V (for 5 V) , $V_{DD} = 3.0$ to 3.6 V (for 3 V) , $V_{SS} = 0$ V, $T_a = 0$ to $+70$ °C)

| Parameter | | Symbol | Value | | Unit |
|----------------------|----------|----------|-------|---------------|------|
| | | | Min. | Max. | |
| Power supply voltage | at 5 V*1 | I_{DD} | — | 50 | mA |
| | at 3 V*2 | | — | 200 (10)*3 | |

*1 : The 5 V power supply is the voltage applied at the VDD5/3 and VDD5 power supply pins.

*2 : The 3 V power supply is the voltage applied at the DVDD3 and AVDD3 power supply pins.

*3 : Supply current in sleep mode.

(1) PCI Interface

($V_{DD} = 3.0$ to 3.6 V, $T_a = 0$ to $+70$ °C)

| Parameter | Symbol | Condition | Value | | Unit |
|--------------------------|-----------|------------------------|----------------------|----------------------|---------|
| | | | Min. | Max. | |
| "H" level input voltage | V_{IH} | — | $V_{DD3} \times 0.5$ | $V_{DD3} + 0.5$ | V |
| "L" level input voltage | V_{IL} | — | $V_{SS} - 0.5$ | $V_{DD3} \times 0.3$ | V |
| "H" level output voltage | V_{OH} | $I_{OH} = -0.5$ (mA) | $V_{DD3} \times 0.9$ | — | V |
| "L" level output voltage | V_{OL} | $I_{OL} = 1.5$ (mA) | — | $V_{DD3} \times 0.1$ | V |
| Input leak current | I_{IL} | $0 < V_{IN} < V_{DD3}$ | — | ± 10 | μ A |
| Input pin capacitance | C_{IN} | — | — | 10 | pF |
| Clock pin capacitance | C_{CLK} | — | 5 | 12 | pF |

(2) PCI Interface

($V_{DD} = 4.75$ to 5.25 V, $T_a = 0$ to $+70$ °C)

| Parameter | Symbol | Condition | Value | | Unit |
|--------------------------|-----------|----------------------|----------------|-----------------|---------|
| | | | Min. | Max. | |
| "H" level input voltage | V_{IH} | — | 2.0 | $V_{DD5} + 0.5$ | V |
| "L" level input voltage | V_{IL} | — | $V_{SS} - 0.5$ | 0.8 | V |
| "H" level output voltage | V_{OH} | $I_{OH} = -2.0$ (mA) | 2.4 | — | V |
| "L" level output voltage | V_{OL} | $I_{OL} = 3.0$ (mA) | — | 0.55 | V |
| Input leak current | I_{IH} | $V_{IN} = 2.7$ (V) | — | ± 10 | μ A |
| | I_{IL} | $V_{IN} = 0.5$ (V) | — | ± 10 | μ A |
| Input pin capacitance | C_{IN} | — | — | 10 | pF |
| Clock pin capacitance | C_{CLK} | — | 5 | 12 | pF |

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(3) Memory Interface

| Parameter | Symbol | Condition | Value | | Unit |
|--------------------------------------|----------|----------------------|----------------|-----------------|-----------|
| | | | Min. | Max. | |
| "H" level input voltage | V_{IH} | — | 2.0 | $V_{DD5} + 0.5$ | V |
| "L" level input voltage | V_{IL} | — | $V_{SS} - 0.5$ | 0.8 | V |
| "H" level output voltage | V_{OH} | $I_{OH} = -4.0$ (mA) | 2.4 | — | V |
| "L" level output voltage | V_{OL} | $I_{OL} = 4.0$ (mA) | — | 0.4 | V |
| Input leak current*1 | I_{IH} | $V_{IN} = 2.7$ (V) | — | ± 10 | μA |
| | I_{IL} | $V_{IN} = 0.5$ (V) | — | ± 10 | μA |
| Input pull-up/pull-down resistance*2 | R_P | $V_{IH} = V_{DD5}$ | 25 | 100 | $k\Omega$ |

*1 : For input at 3-state pin.

*2 : Typical resistance value 50 $k\Omega$.

(4) CLK, CSCLK Pins

| Parameter | Symbol | Condition | Value | | Unit |
|------------------------------------|-----------|------------------------|----------------------|----------------------|-----------|
| | | | Min. | Max. | |
| "H" level input voltage | V_{IH} | — | $V_{DD3} \times 0.7$ | $V_{DD3} + 0.3$ | V |
| "L" level input voltage | V_{IL} | — | V_{SS} | $V_{DD3} \times 0.2$ | V |
| Input leak current* | I_{IL} | $0 < V_{IN} < V_{DD3}$ | -5 | +5 | μA |
| Input pull-up/pull-down resistance | R_P | $V_{IH} = V_{DD3}$ | 25 | 200 | $k\Omega$ |
| Clock pin capacitance | C_{CLK} | — | TBD | TBD | pF |

* : For input at 3-state pin.

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(5) 1394 Interface

| Parameter | Symbol | Condition | Value | | Unit |
|---|--------------|----------------------|-------------------|-------------------|---------|
| | | | Min. | Max. | |
| Differential output voltage | V_{OD} | 56 Ω terminal | 172 | 265 | mV |
| Common phase current | I_{CM} | Transceiver OFF | -0.81 | 0.44 | mA |
| Off state voltage | V_{OFF} | Transceiver OFF | — | 20 | mV |
| Speed-signal drive current | — | S100 | -0.81 | 0.44 | mA |
| | | S200 | -2.53 | -4.84 | mA |
| | | S400 | -8.10 | -12.40 | mA |
| TPBIAS output voltage*1 | V_O | — | 1.665 | 2.015 | V |
| DS comparator offset voltage*2 | V_{IT} | — | -30 | 30 | mV |
| Arbitration comparator offset voltage*2 | V_{ITH} | — | 89 | 168 | mV |
| | V_{ITL} | — | -168 | -89 | mV |
| Speed-signal comparator offset voltage*3 | V_{IT} | S200 | 120 | 180 | mV |
| | | S400 | 290 | 380 | mV |
| Port status comparator offset voltage*4 | V_{IT} | — | 0.6 | 1.0 | V |
| Schmitt trigger receiver threshold voltage for detection connection | V_{IT+} *6 | — | 1.95 | 2.40 | V |
| | V_{IT-} *6 | — | 1.00 | 1.45 | V |
| Comparator offset voltage for detecting cable power supply | V_{IT} | — | 1.125 (7.5) *5 | 1.275 (8.5) *5 | V |
| CPS pin input voltage | V_{CPS} | — | V_{SS} | V_{DD5} | V |
| Common input current | I_{IC} | — | -20 | 20 | μA |

*1 : When the TPBIAS supply is Off, the maximum value with cable connected is 0.4 V, and when the cable is not connected the maximum output voltage is V_{DD} .

* 2 : Electrical potential created between TPA and TPB pins.

*3 : Electrical potential created between TPBIAS and TPA/B pins

*4 : At a point midway between the TPB/TPB# pins.

*5 : Cable supply voltage (VP) : voltage before division by 510 k Ω to 91 k Ω resistance

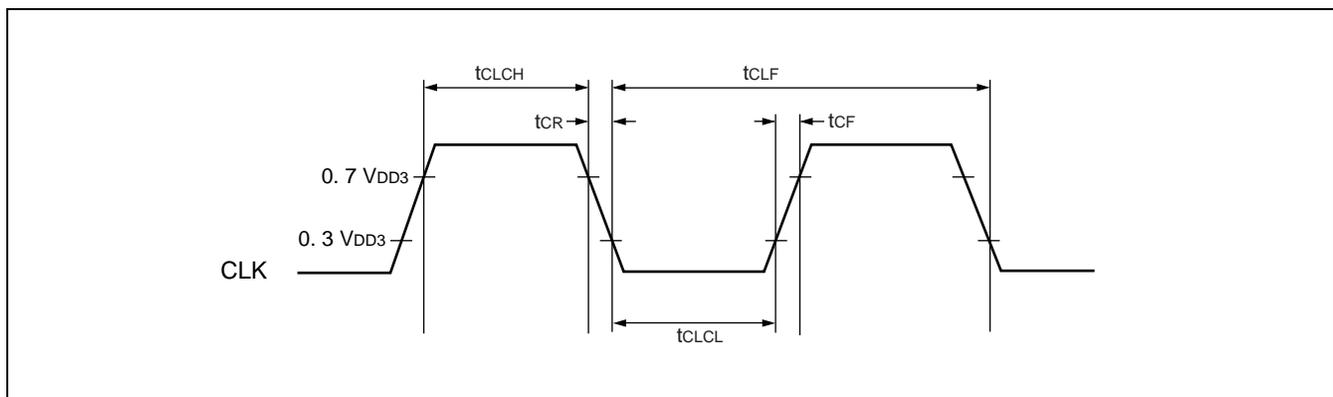
*6 : VIT+ is the voltage before cable disconnection is detected. VIT- is the voltage after cable connection is detected.

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2. AC Characteristics

(1) CLK

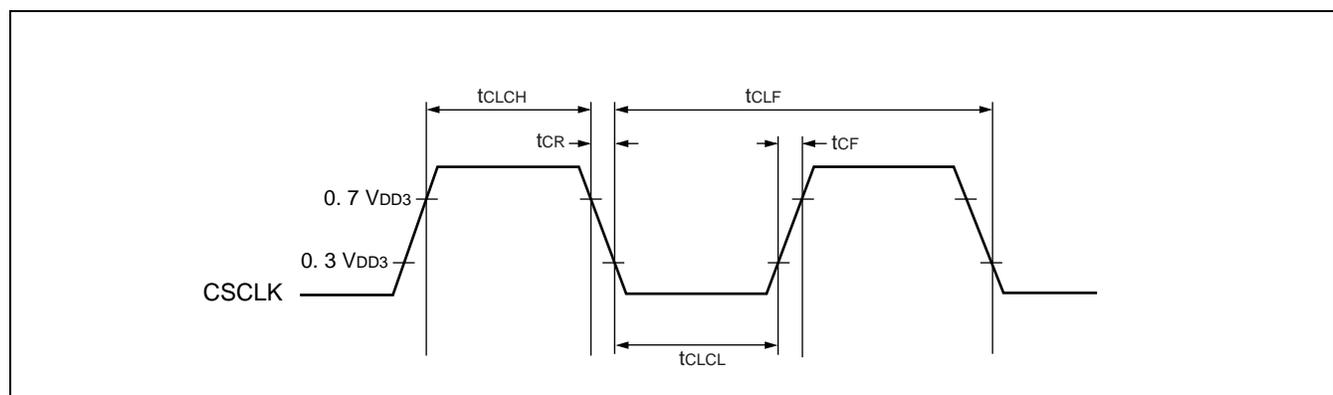
| Parameter | Symbol | Condition | Value | | Unit |
|----------------------|----------------------|-----------|-----------|------|---------------|
| | | | Min. | Max. | |
| Clock frequency | f_c | — | 24.576 | | MHz |
| Clock cycle time | t_{CLF} | — | $1 / f_c$ | | μs |
| Clock pulse width | t_{CLCH}, t_{CLCL} | — | 10 | — | ns |
| Clock rise/fall time | t_{CR}, t_{CF} | — | — | 5 | ns |



Note : The CLK pin is the pin used for input of the reference clock signal for the built-in PLL circuit.

(2) CSCLK

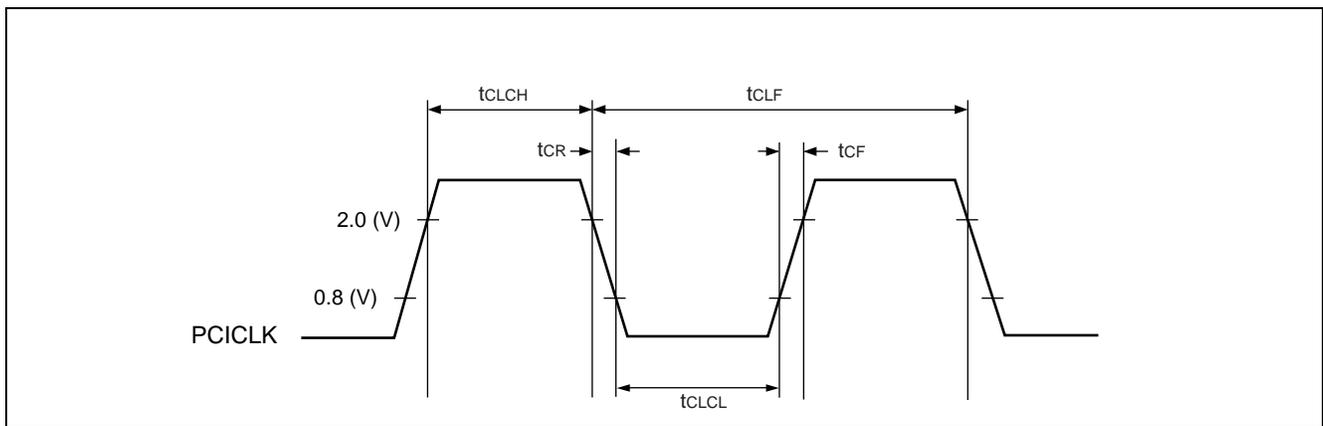
| Parameter | Symbol | Condition | Value | | Unit |
|----------------------|----------------------|-----------|-----------|------|---------------|
| | | | Min. | Max. | |
| Clock frequency | f_c | — | 8 | | kHz |
| Clock cycle time | t_{CLF} | — | $1 / f_c$ | | ms |
| Clock pulse width | t_{CLCH}, t_{CLCL} | — | 50 | — | μs |
| Clock rise/fall time | t_{CR}, t_{CF} | — | — | 5 | ns |



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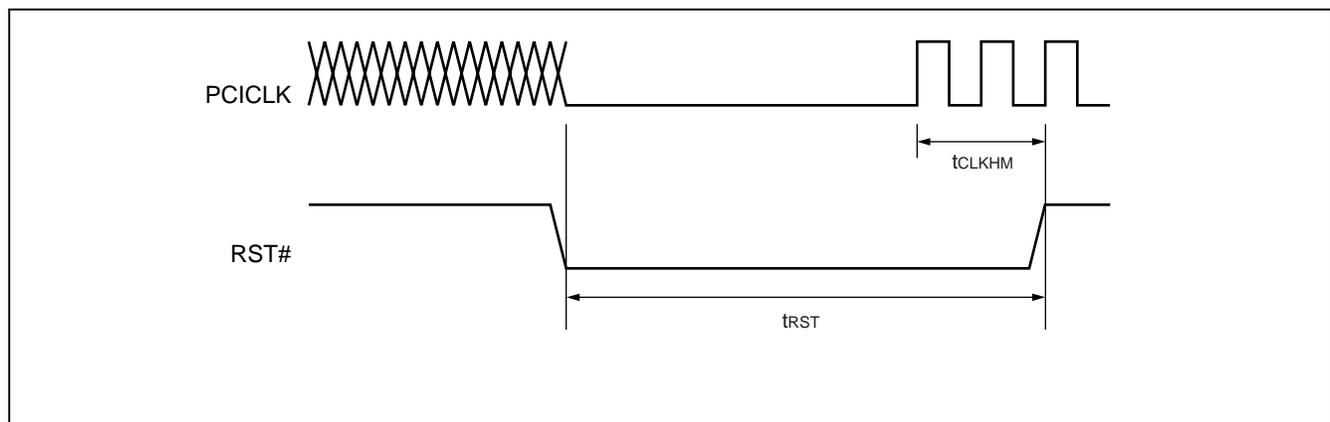
(3) PCICLK

| Parameter | Symbol | Condition | Value | | Unit |
|----------------------|----------------------|-----------|-------|----------|------|
| | | | Min. | Max. | |
| Clock frequency | f_c | — | — | 33 | MHz |
| Clock cycle time | t_{CLF} | — | 30 | ∞ | ns |
| Clock pulse width | t_{CLCH}, t_{CLCL} | — | 11 | — | ns |
| Clock rise/fall time | t_{CR}, t_{CF} | — | — | 6 | ns |
| Slew rate | — | — | 1 | 4 | V/ns |



(4) RST#

| Parameter | Symbol | Condition | Value | | Unit |
|-------------------------------------|-------------|-----------|-------|------|---------|
| | | | Min. | Max. | |
| Hold time after power stabilization | t_{RST} | — | 0 | — | PCI CLK |
| Hold time after clock stabilization | t_{CLKHM} | — | 6 | — | PCI CLK |



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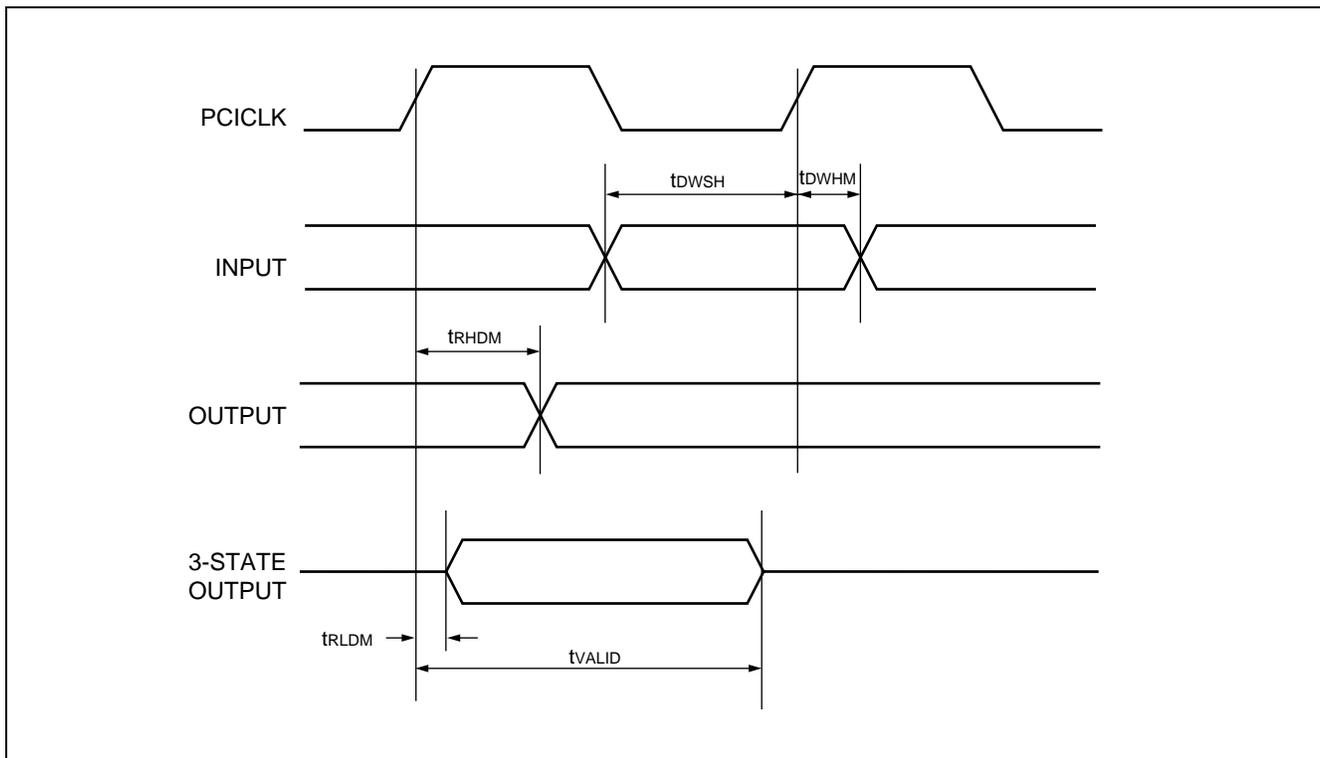
(5) Transceiver

| Parameter | Symbol | Condition | Value | | Unit |
|-----------------------|--------|------------|-------|------------|------|
| | | | Min. | Max. | |
| Transceiver rise time | T_R | 10% to 90% | — | 1.2 | ns |
| Transceiver fall time | T_F | 90% to 10% | — | 1.2 | ns |
| Sending output jitter | — | — | — | ± 0.15 | ns |
| Sending output skew* | — | — | — | ± 0.10 | ns |

* : Skew between TPA pin and TPB pin.

(6) PCI Bus

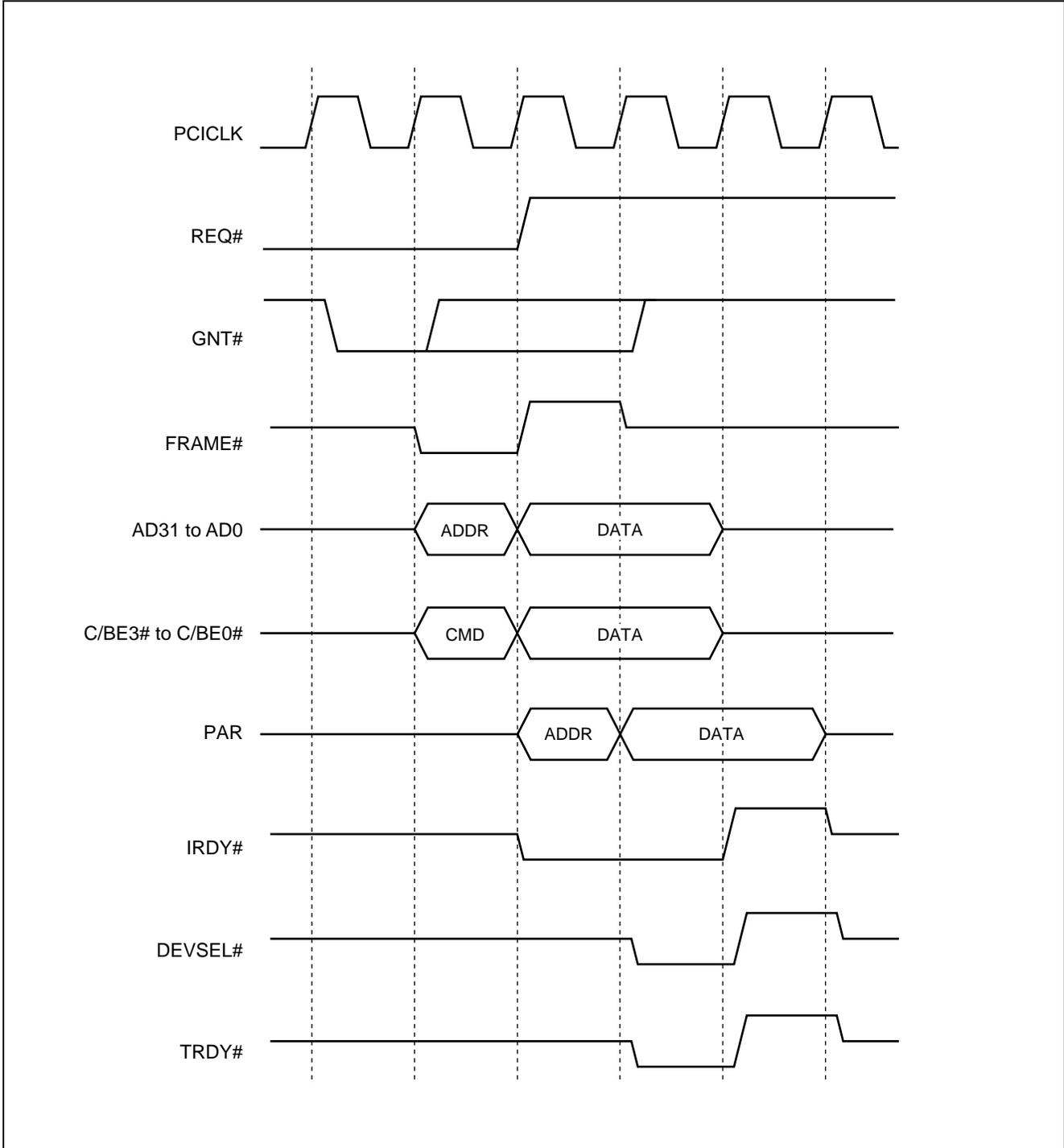
| Parameter | Symbol | Condition | Value | | Unit |
|-------------------------------|-------------|-----------|------------|-------------|------|
| | | | Min. | Max. | |
| Input data setup time | t_{DWSH} | — | 7 (10)* | — | ns |
| Input data hold time | t_{DWHM} | — | 1 (1)* | — | ns |
| Data output delay time | t_{RHDM} | — | 2 (2)* | 11 (12)* | ns |
| Output data verification time | t_{RLDM} | — | 2 | — | ns |
| Output data valid time | t_{VALID} | — | — | 28 | ns |



* : Between REQ# and GNT# pins.

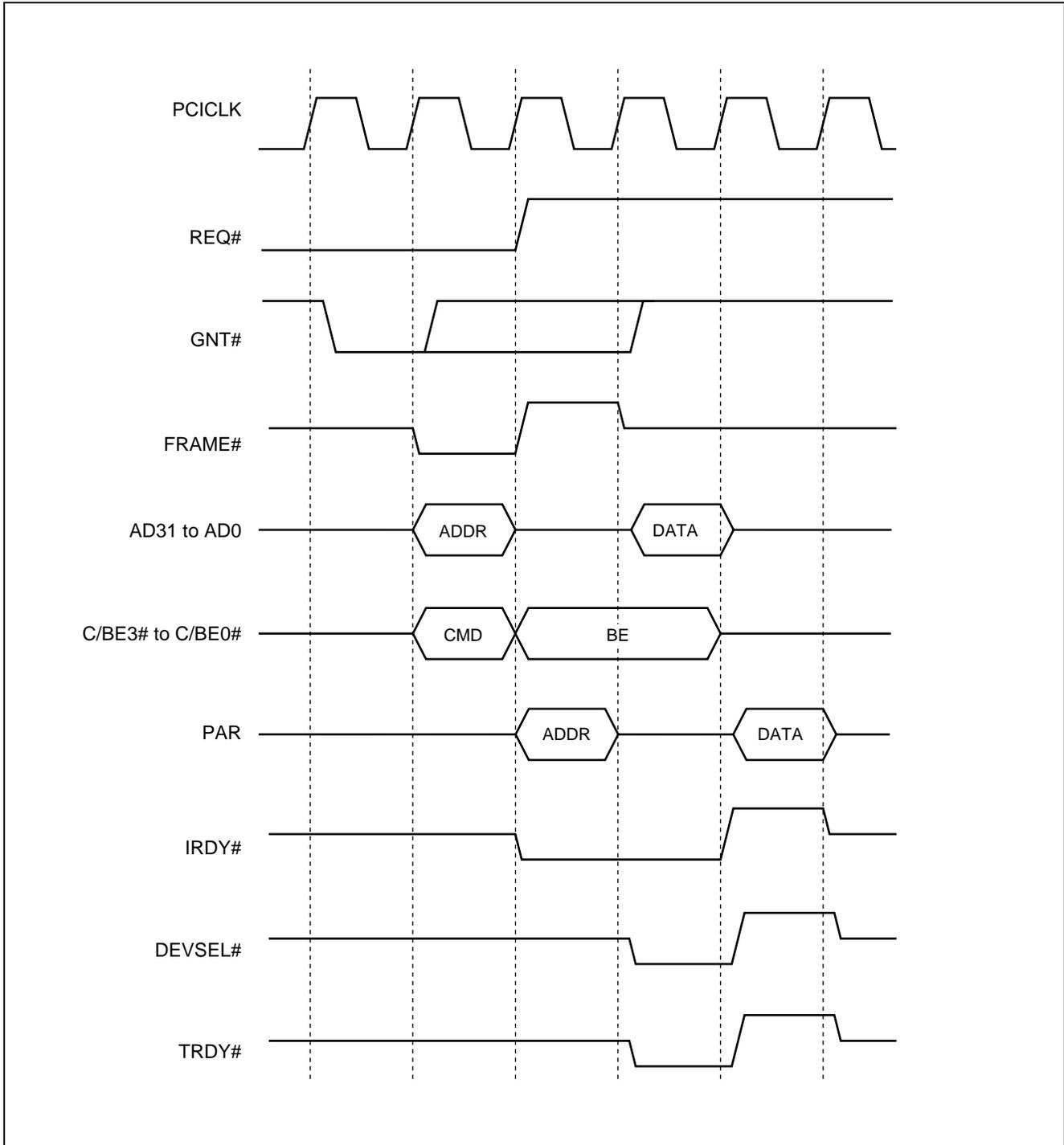
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• Bus Master Write Operation



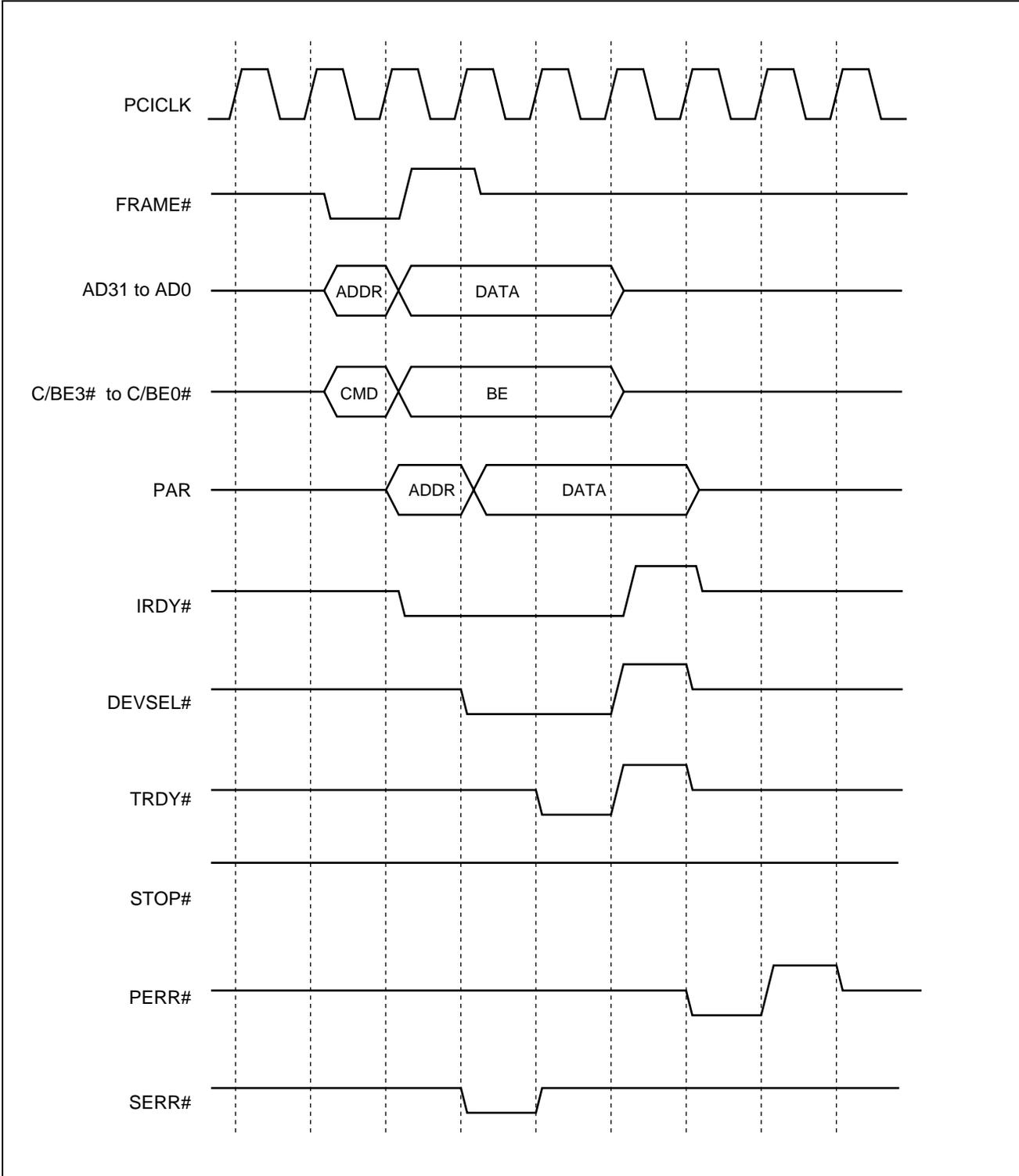
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• Bus Master Read Operation



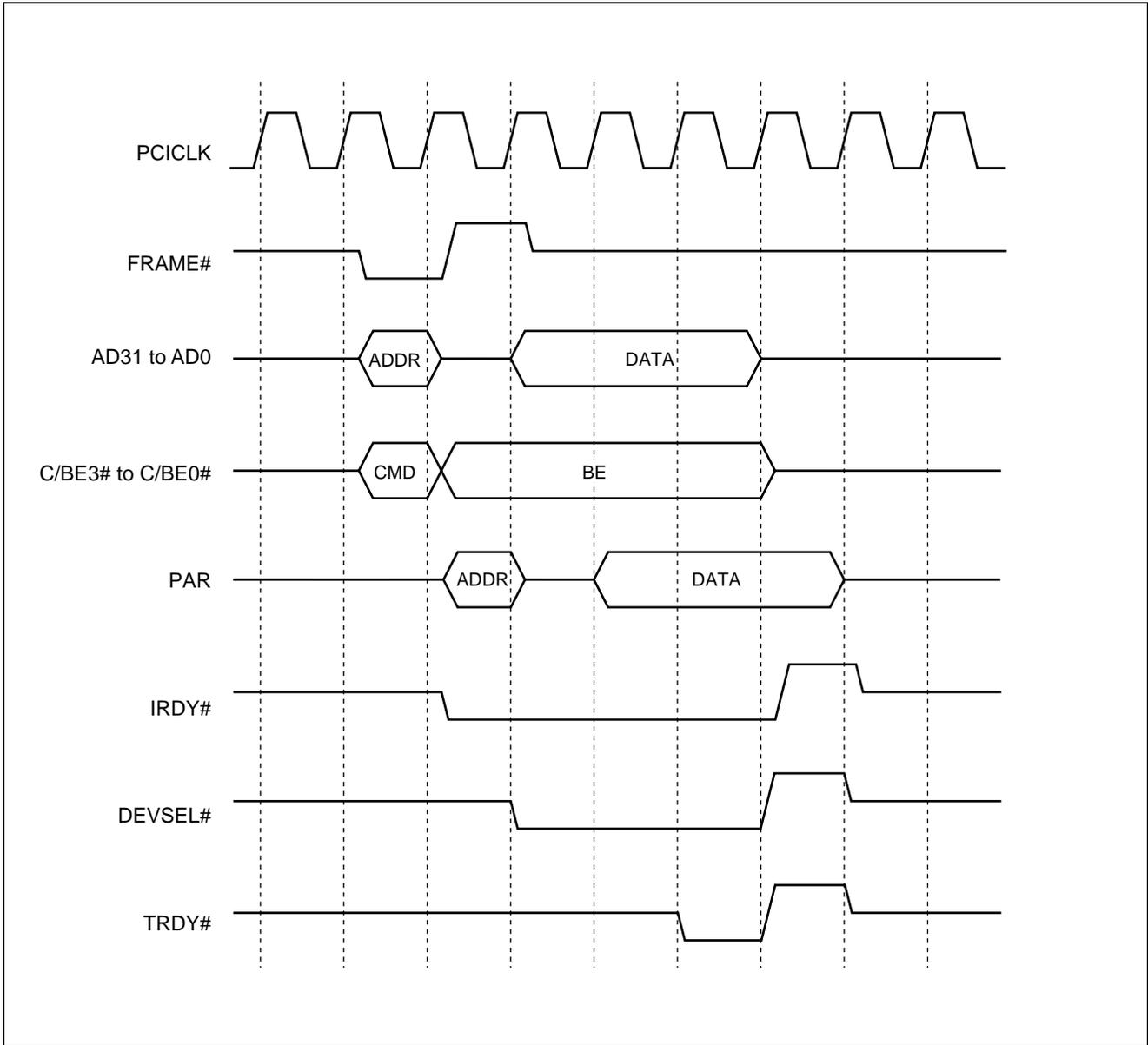
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• Slave Write Processing



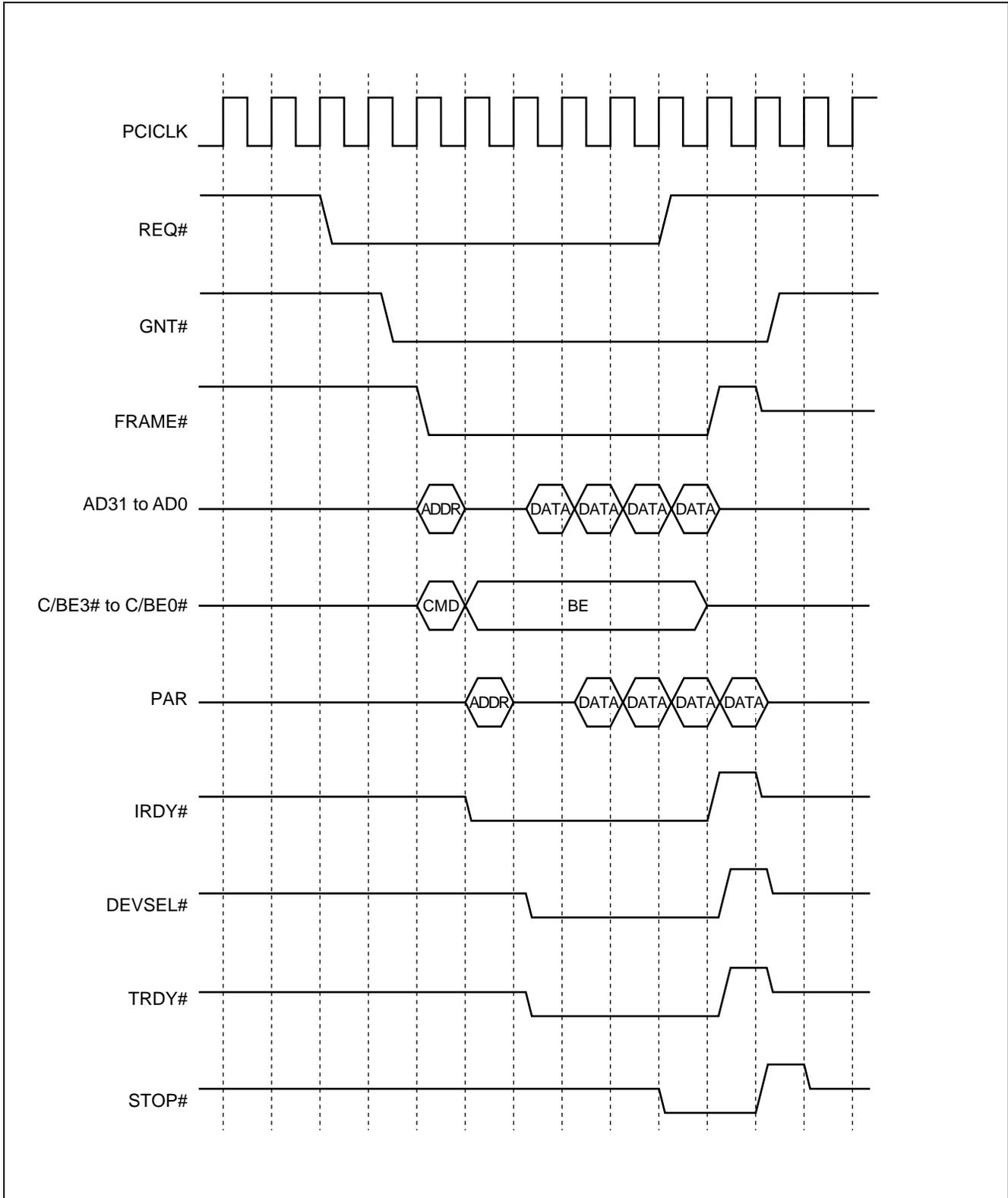
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• Slave Read Processing



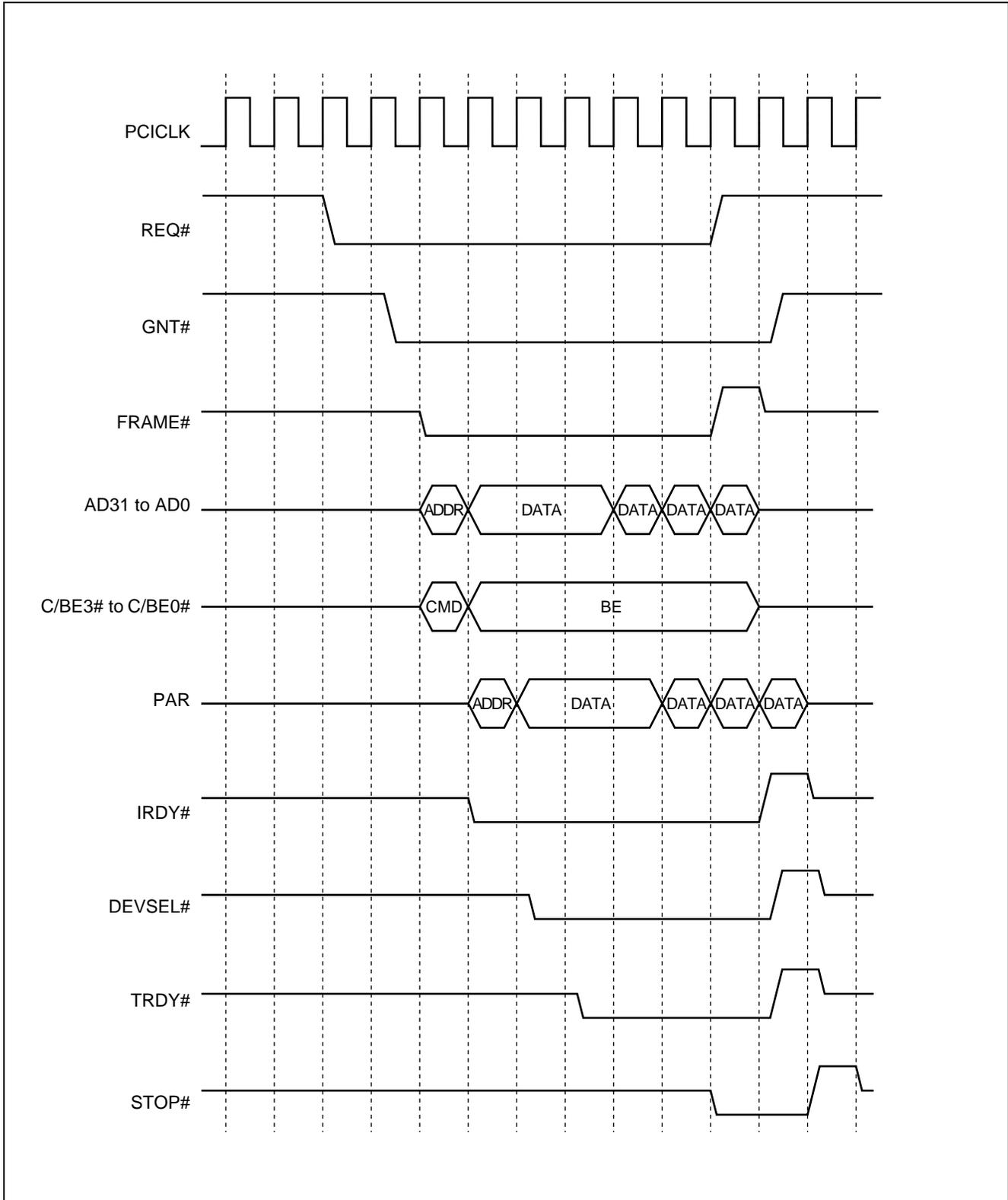
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• Bus Master Burst Read Processing



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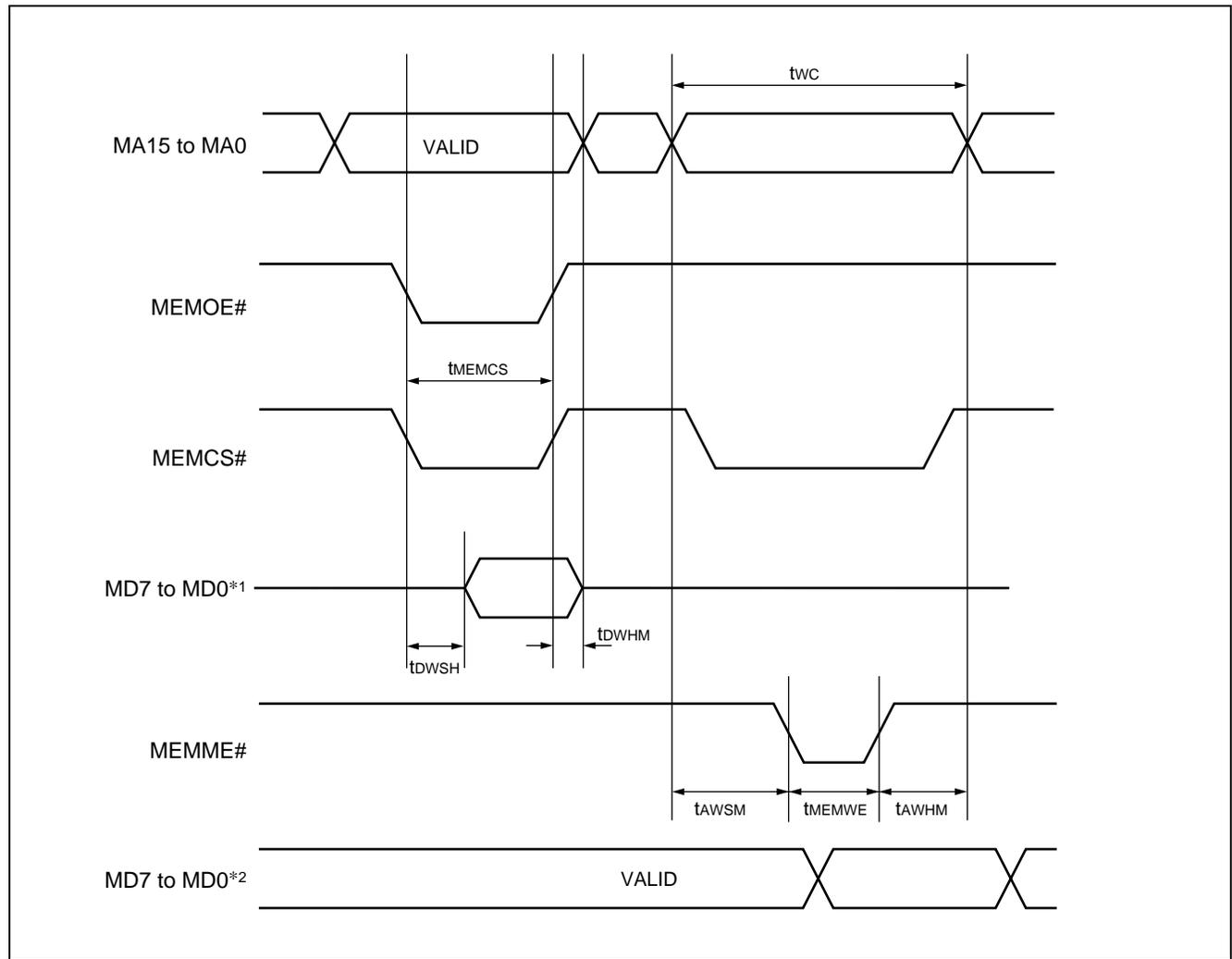
• Bus Master Burst Write Processing



(7) Memory Interface

• EPROM

| Parameter | Symbol | Condition | Value | | Unit |
|-------------------------------------|-------------|-----------|-------|------|------|
| | | | Min. | Max. | |
| MEMCS# signal "L" level output time | t_{MEMCS} | — | — | 50 | ns |
| Input data definition time | t_{DWSH} | — | — | 10 | ns |
| Input data hold time | t_{DWHM} | — | — | 10 | ns |
| Write cycle time | t_{WC} | — | — | 50 | ns |
| Address setup time | t_{AWSM} | — | 13 | — | ns |
| Address hold time | t_{AWHM} | — | 15 | — | ns |
| MEMWE# signal pulse width | t_{MEMWE} | — | 25 | — | ns |



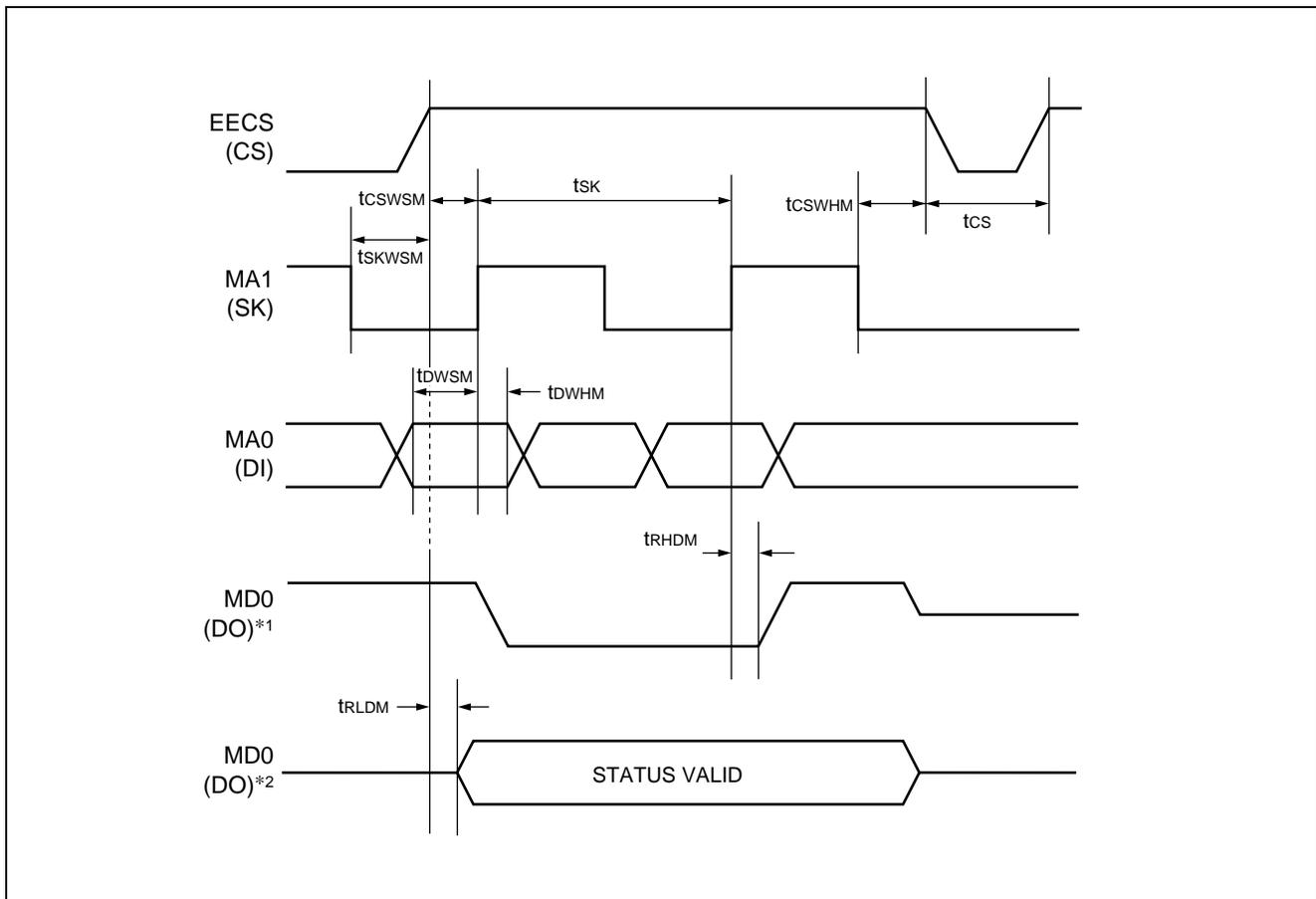
*1 : For EPROM read processing.

*2 : For EPROM write processing.

MB86613

• EEPROM

| Parameter | Symbol | Condition | Value | | Unit |
|---------------------------------|-------------|-----------|-------|------|------|
| | | | Min. | Max. | |
| Clock cycle time | t_{SK} | — | 1000 | — | ns |
| CS signal setup time | t_{CSWSM} | — | 50 | — | ns |
| SK signal setup time | t_{SKWSM} | — | 50 | — | ns |
| CS signal "L" level output time | t_{CS} | — | 250 | — | ns |
| Data output hold time (for DO) | t_{RHDM} | — | 20 | — | ns |
| Input data setup time (for DI) | t_{DWSM} | — | 100 | — | ns |
| Input data hold time (DI) | t_{DWHM} | — | 20 | — | ns |
| CS signal hold time | t_{CSWHM} | — | 0 | — | ns |
| Status output definition time | t_{RLDM} | — | 500 | — | ns |



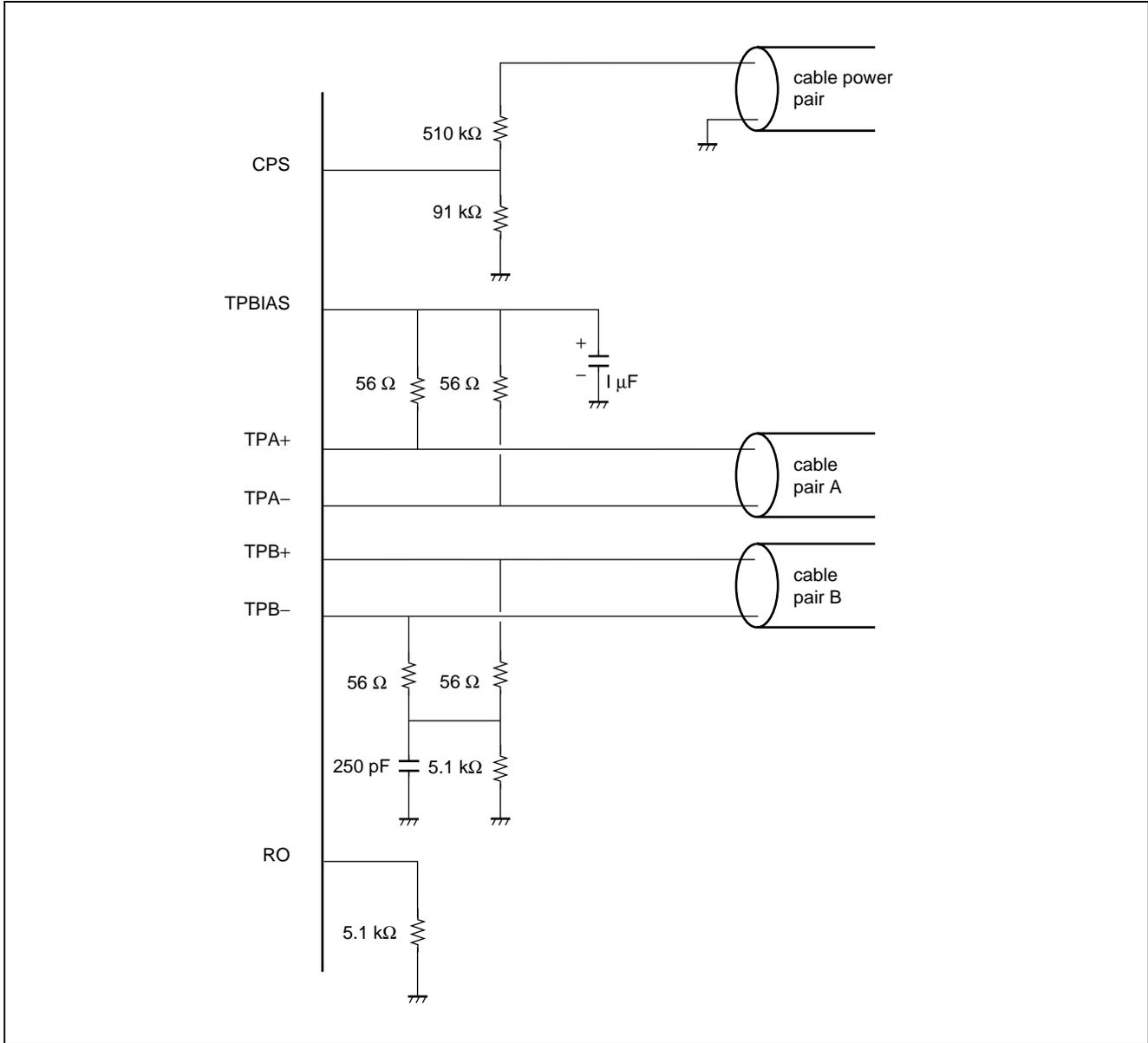
*1 : For EPROM read processing.

*2 : For EPROM write processing.

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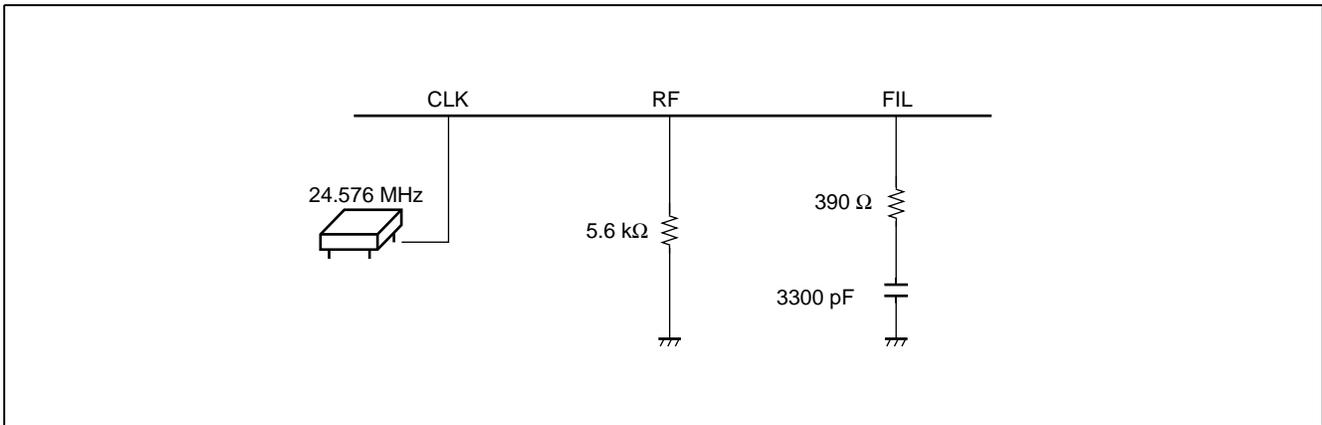
■ COMPONENT CONNECTION DIAGRAM

1. 1394 Port

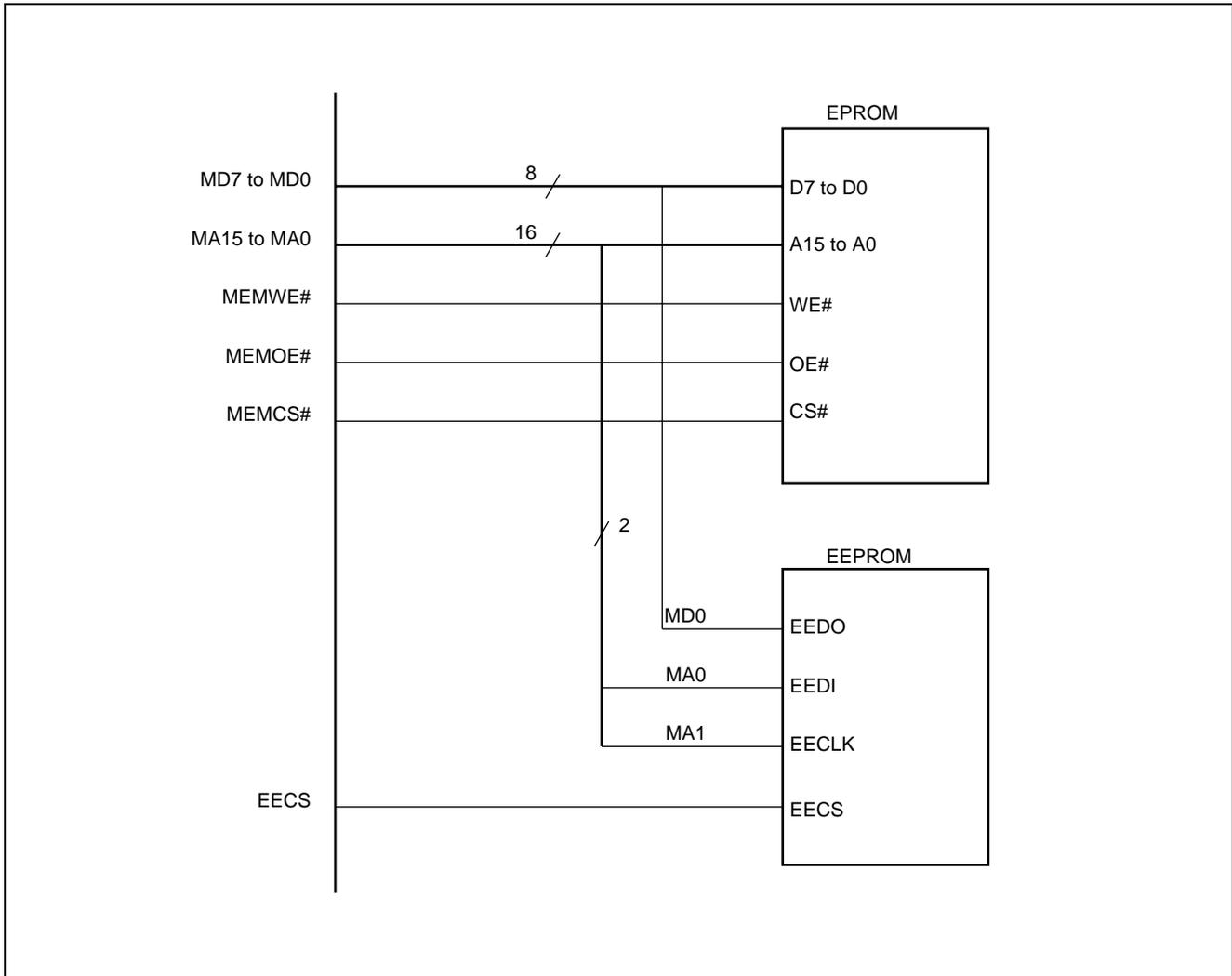


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2. Filter Circuit



3. Memory Interface

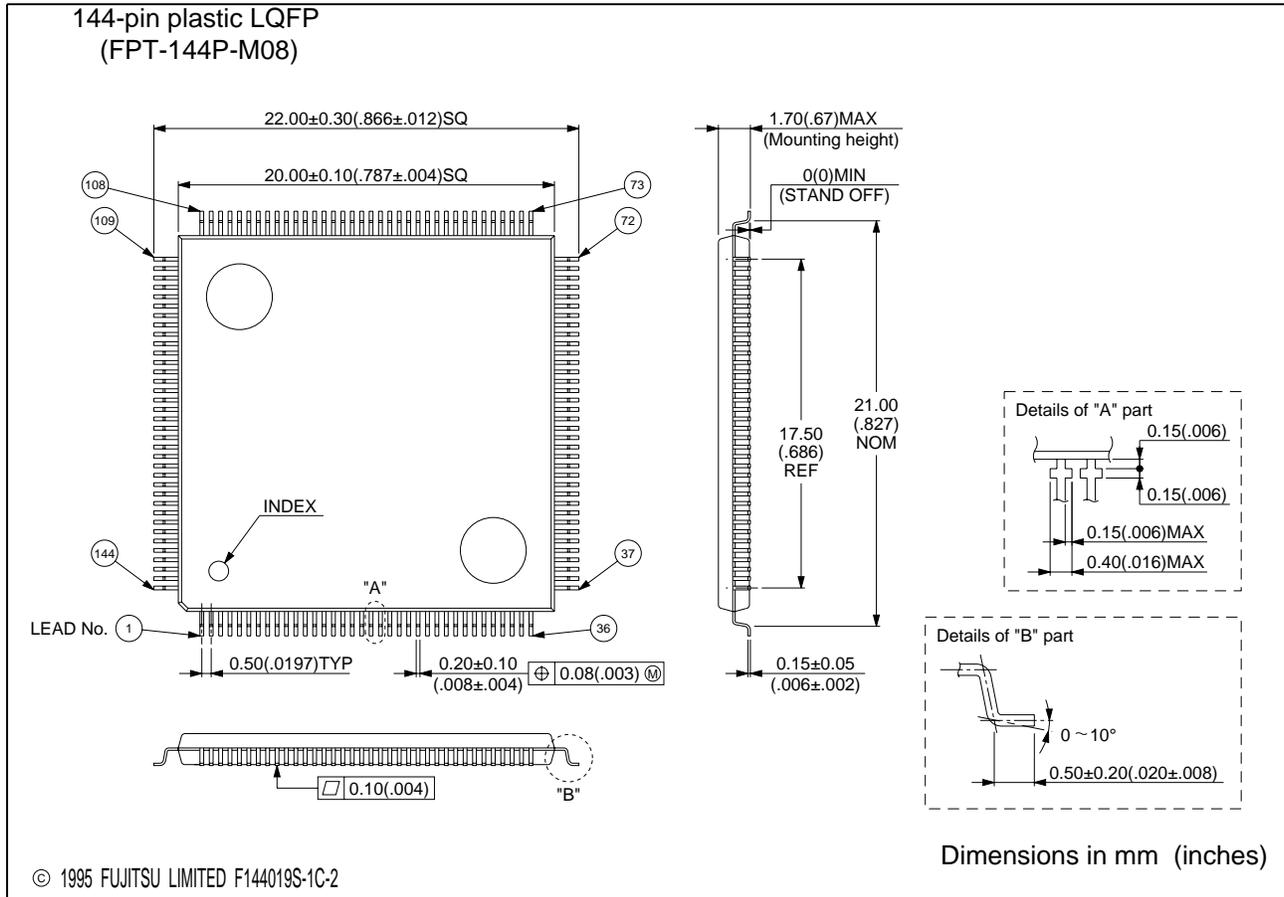


MB86613**■ ORDERING INFORMATION**

| Part number | Package | Remark |
|-------------|--|--------|
| MB86613PFV | 144-pin Plastic LQFP (FPT-144P-M08) | |
| MB86613PBT | 176-pin Plastic FBGA (BGA-176P-M02) | |

MB86613

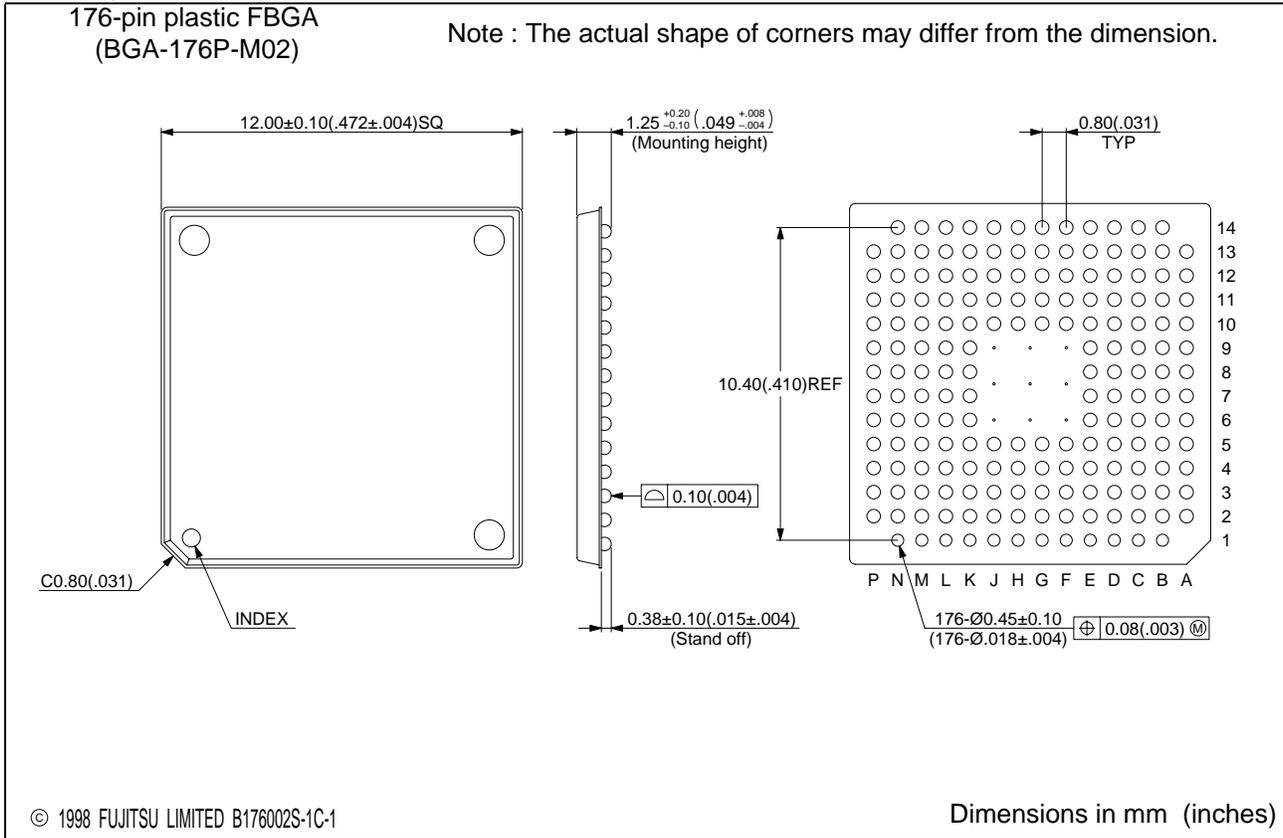
■ PACKAGE DIMENSIONS



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MB86613

(Continued)



MB86613

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